

Hot Swap, Smart Fuse 18 V, 0.65 m Ω , 50 A, LQFN32

NCP81428

General Description

The NCP81428 is a PMBus [®] enabled, 12 V, 50 A resettable in–line fuse designed for comprehensive protection against over current events, over voltage events, short circuit events, and excessive inrush current. The NCP81428 consists of a 0.65 m Ω NMOS FET, a high performance Hot–Swap Controller, and a Non–Volatile Memory (NVM) all co–packaged into a LQFN32 package. The NCP81428 can be configured as a single–phase solution, or in multi–phase as a Master or a Slave to support higher current applications.

Power Features

- Up to 80 A Peak Output Current, 50 A Continuous
- VIN Operating Range: 5 to 18 V
- Up to 30 V Standby (PowerFet Off) Operation
- 0.65 mΩ Path Resistance

Control Features

- Enabled by Pin Assertion and/or Through PMBus
- Output Pulldown Selection Via PMBus
- External Soft-Start Programming
- Programmable VIN Under Voltage Warning and Overvoltage Fault
- Programmable OCP Levels and Timers
- Soft Start Current Balancing between Parallel Units

Other Features

- Co-packaged Power Switch, Hotswap Controller and NVM
- (TWI) Two Wire Interface between Master and Slave(s)
- PMBus 1.4 Compliant for Telemetry
- ±2% IMON Accuracy at 30 A and Higher
- 10-bit ADC for I_{OUT}, V_{IN}, I_{OUT pk}, V_{OUT}, V_{TEMP}
- Parallel Operation for High Current Applications
- Excellent Current Balancing in Parallel Operations
- Over-temperature Shutdown
- FAULT# C & FAULT#_D Multi-purpose Pins
- Internal FET Health Diagnostics
- Soft-start Current Limiting For SOA Protection
- Excessive Soft-start Duration Protection
- Fault Event and Peak Current Recording
- Programmable Auto Retry/Latch off Options
- 5 mm x 5 mm LQFN32 Package
- Operating Temperature: -40°C to +125°C

Applications

- Servers
- Data Storage
- Base Stations
- Industrial Applications



CASE 487AA

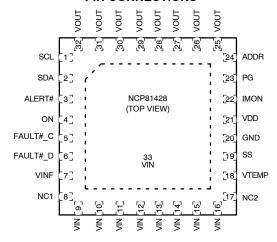
MARKING DIAGRAM



NCP81428 = Specific Device Code A = Assembly Location

WL = Wafer Lot YY = Year WW = Work Week

PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information on page 59 of this data sheet.

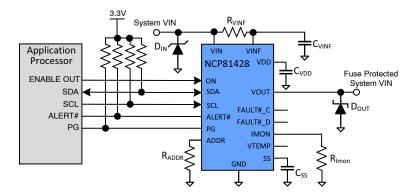


Figure 1. Application Schematic

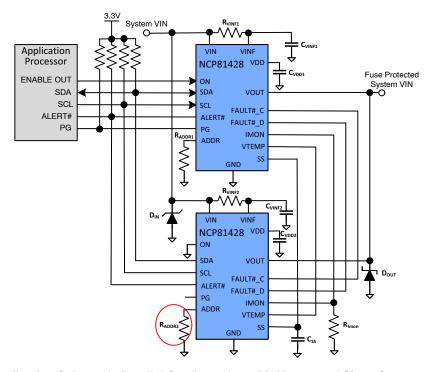


Figure 2. Application Schematic Parallel Configuration with Master and Slave Connected to PMBus

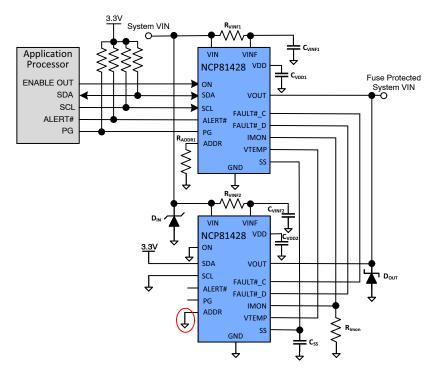


Figure 3. Application Schematic – Parallel Configuration, No PMBus on Slaves and with Master / Slave Communication

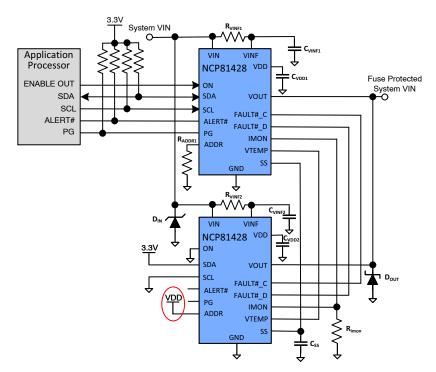


Figure 4. Application Schematic – Parallel Configuration, No PMBus on Slaves and without Master / Slave Communication

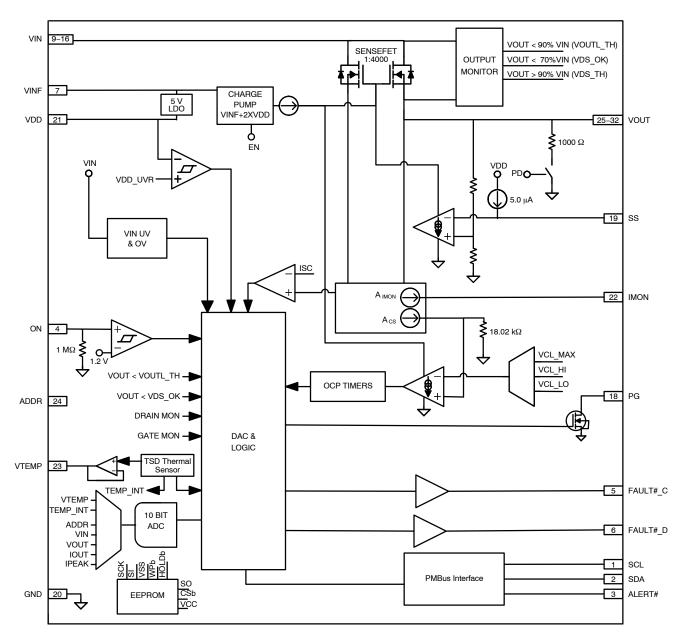
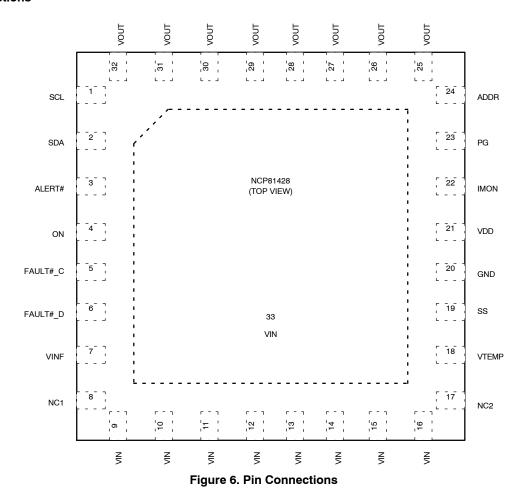


Figure 5. Simplified Block Diagram

Pin Connections



PIN FUNCTION DESCRIPTION

Pin No.	Symbol	Description
1	SCL	PMBus serial clock. Short to GND if not used.
2	SDA	PMBus serial data input/output. Pull-up to 3.3 V if not used.
3	ALERT#	ALERT# pin is an Open drain output. A logic low alert signal of the PMBus interface.
4	ON	Active high, enable input.
5	FAULT#_C	Active low Fault communication pin in parallel application between master and slave devices. Connect FAULT#_C pins together in parallel applications. This pin is an output on the master and an input on the slave.
6	FAULT#_D	Active low Fault communication pin in parallel application between master and slave devices. Connect FAULT#_D pins together in parallel application.
7	VINF	Control circuit power supply input. Connect to VIN pins through an RC filter.
8	NC1	Do not connect to this pin. Leave floating.
9	VIN09	Input of high current output switch (MOSFET drain connection).
10	VIN10	Input of high current output switch (MOSFET drain connection).
11	VIN11	Input of high current output switch (MOSFET drain connection).
12	VIN12	Input of high current output switch (MOSFET drain connection).
13	VIN13	Input of high current output switch (MOSFET drain connection).
14	VIN14	Input of high current output switch (MOSFET drain connection).
15	VIN15	Input of high current output switch (MOSFET drain connection).
16	VIN16	Input of high current output switch (MOSFET drain connection).
17	NC2	Do not connect to this pin. Leave floating.
18	VTEMP	Analog temperature monitoring. Connect all VTEMP pins together in parallel applications.
19	SS	Soft-start time programming pin. Connect a capacitor to this pin to set the soft-start time. The internal circuit controls the slew rate of the output voltage at turn-on. Connect all SS pins together in parallel applications.
20	GND	Ground
21	VDD	Internal linear regulated supply output. Place a capacitor with a value of 4.7 μF or greater on this pin to maintain accuracy.
22	IMON	Analog current monitor output, Connect a $2 \text{ k}\Omega$ resistor between pin and ground. A proportional current to the output current develops a voltage across the resistor. Connect all IMON pins together in parallel applications.
23	PG	Power Good, Open Drain output pin. Can be connected to VDD with a 100 k Ω pull–up resistor.
24	ADDR	PMBus address-setting pin. Connect a resistor from this pin to GND to set the device address.
25	VOUT25	Output of high current output switch (MOSFET source connection).
26	VOUT26	Output of high current output switch (MOSFET source connection).
27	VOUT27	Output of high current output switch (MOSFET source connection).
28	VOUT28	Output of high current output switch (MOSFET source connection).
29	VOUT29	Output of high current output switch (MOSFET source connection).
30	VOUT30	Output of high current output switch (MOSFET source connection).
31	VOUT31	Output of high current output switch (MOSFET source connection).
32	VOUT32	Output of high current output switch (MOSFET source connection).
33	VIN33	Input of high current output switch (MOSFET drain connection).

MAXIMUM RATINGS

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
VIN, VINF	Input Voltage (Notes 1, 3)		-0.3	-	20.0	V
	Input Voltage (Notes 1, 2)		-0.3	-	30	
VOUT	VOUT Pin Voltage Range (Note 1)		-0.3, -1.0 V (<500 ms)	-	20	٧
VDD	LDO Output (Note 1)		-0.3	-	6.0	V
All Other Pins	Pin Voltage Range (Note 4)		-0.3	-	VDD + 0.3	V
T _{J(MAX)}	Operating Junction Temperature		-	_	+150	°C
T _{STG}	Storage Temperature Range		-55	-	+150	°C
T _{SLD}	Lead Temperature Soldering Reflow (SMD Styles Only) Pb- Free Versions (Note 5)		-	-	+260	°C
ESD _{CDM}	Electrostatic Discharge – Charged Device Model	Charged Device Model	-	-	2.0	kV
ESD _{HBM}	Electrostatic Discharge – Human Body Model	Human Body Model	-	-	3.0	kV
C _{FAULT#_C} , C _{FAULT#_D}	PCB Capacitance on FAULT#_C and FAULT#_D Pins		-	-	200	pF

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. All signals referenced to ground unless noted otherwise.
- 2. Vout disabled is when the internal Power FET has turned off by disabling the device or after triggering a fault event.
- 3. Vout enabled is when the internal Power FET has turned on either by enabling the device or after restart fault event.
- 4. The ratings of Pins referenced to VDD, only apply when VDD is within the recommended Voltage Range.
- 5. For information, please refer to **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

THERMAL CHARACTERISTICS

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{ heta JA}$	Junction-to-Ambient Thermal Resistance (Note 6)		-	30	-	°C/W
$R_{\theta JCT}$	Junction-to-Top-Case Thermal Resistance		-	50	-	°C/W
$R_{\theta JCB}$	Junction-to-Bottom-Case Thermal Resistance		-	1.5	-	°C/W
$R_{ heta JB}$	Junction-to-Board Thermal Resistance (Note 7)		-	1.5	-	°C/W
$R_{ heta JAC}$	Junction-to-Case Thermal Resistance (Note 8)		-	1.5	-	°C/W

- 6. Theta JA is obtained by simulating the device mounted on a 500 mm², 1-oz Cu pad on a 80 mm x 80 mm, 1.6 mm 8 layer FR4 board.
- 7. Theta JB value based on hottest board temperature within 1 mm of the package.
- 8. Theta JC ~ = Theta JCT // Theta JCB (Two-Resistor Compact Thermal Model, JESD15-3).

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
	VIN, VINF Pin Voltage Range		5	-	18	V
I _{AVE}	Minimum Continuous Output Current		-	-	50	Α
I _{PEAK}	Peak Output Current		-	-	80	Α
C _{VDD}	VDD Output Load Capacitance Range		4.7	-	10	μF
C _{OUT}	Output Capacitance Range		100	-	10000	μF
T _{SS}	Soft Start Duration		10	-	110	ms
R _{IMON}	IMON Resistor		1.98	2	2.02	kΩ
T _{J(OP)}	Junction Temperature		-40	-	+125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

ELECTRICAL CHARACTERISTICS (Typical values are at T_J = 25°C, VIN = VINF = 12.0 V, V_{ON} = 3.3 V, C_{VINF} = 0.1 μ F, C_{VDD} = 4.7 μ F, C_{SS} = 100 nF. Min/Max values are valid for 6 V ≤ VIN ≤ 18 V, -40°C ≤ T_J ≤ +125°C, unless otherwise noted.)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
VINF INPUT				•	•	
I _{q_OP}	Operating Current	V _{ON} > 1.3 V, No Load	-	9.5	14	mA
VDD REGULAT	OR					
V _{DD_NL}	VDD Output Voltage	1 mA < I _{VINF} <10 mA, 6 V < V _{INF} < 18 V	4.7	5.0	5.3	V
V_{DD_UVR}	UVLO Threshold - Rising		4.1	4.3	4.5	V
V _{DD_UVF}	UVLO Threshold – Falling		3.5	3.7	3.9	V
I _{DD_CL}	VDD Current Limit	6 V < V _{INF} < 18 V, V _{DD} – 100 mV	20	25	50	mA
I _{DD_FLD}	VDD Short Circuit Current Limit	6 V < V _{INF} < 18 V, V _{DD} = 0 V	5	13	25	mA
ON INPUT						
V_{SWON}	Rising Switch ON Threshold		1.10	1.20	1.30	V
V _{ON_HYS}	ON Comparator Hysteresis		-	100	-	mV
t _{ON}	Switch ON Delay Timer	From ON transitioning above V _{SWON} to SS start.	0.6	1.0	1.4	ms
t _{OFF}	Switch OFF Delay Timer	From ON transitioning below V _{ONhys} to PowerFET OFF, No Load	-	-	2	μs
R _{ON_PD}	Input Pulldown Resistance	V _{IN} = 12 V	0.7	1.0	1.3	МΩ
SS PIN						
I _{SS}	Bias Current	Force Vss = 0 V	4.5	5.0	5.5	μА
AV _{SS}	Gain at VOUT	V _{SS} = 1.0 V	9.7	10	10.3	V/V
V _{OL_SS}	SS PullDown Voltage	0.1 mA into pin during ON delay	-	3.5	7.5	mV
MON OUTPUT						
TOL _{IMON}	Accuracy (Single eFuse)	IOUT = 8 A, VIN = 12 V, T _J = 25°C	-4	-	+4	%
		IOUT = 15 A (Note 9), VIN = 12 V, T _J = 25°C	-2.5	-	+2.5	
		IOUT = 30 A (Note 9), VIN = 12 V, T _J = 25°C	-2	-	+2	
		IOUT = 50 A (Note 9), VIN = 12 V, T _J = 25°C	-2	-	+2	
V _{IMON_CLMP}	IMON Current Source Clamp Voltage	Max pullup voltage of current source	2.4	3.0	-	V
CURRENT LIMI	T at SOFTSTART					
/IN < 13.2 V						
I _{CS_LO}	Current Limit Clamp Voltage, Low VIN (Note 9)	V _{OUT} < 0.4 x V _{IN} , V _{IN} < 13.2 V	6	7.5	9	Α
I _{CS_HI}	Current Limit Clamp Voltage, Low VIN (Note 9)	0.4 x V _{IN} < V _{OUT} < 0.8 x V _{IN} , V _{IN} < 13.2 V	12	15	18	
I _{CS_MAX}	Current Limit Max Clamp Voltage, Low VIN (Note 9)	0.8 x V _{IN} < V _{OUT} , Vt < V _{GS} , VIN < 13.2 V	24	30	36	Α
t _{CL_REG}	CL Duration before SD (Note 9)		200	250	300	μs
/IN > 13.2 V	•	•	•	•	•	
I _{CS_LO}	Current Limit Clamp Voltage, High VIN (Note 9)	V _{OUT} < 0.4 x V _{IN} , V _{IN} > 13.2 V	4	5	6	Α
I _{CS_HI}	Current Limit Clamp Voltage, High VIN (Note 9)	0.4 x V _{IN} < V _{OUT} < 0.8 x V _{IN} , V _{IN} > 13.2 V	8	10	12	
I _{CS_MAX}	Current Limit Max Clamp Voltage, High VIN (Note 9)	0.8 x V _{IN} < V _{OUT} , Vt < V _{GS} , V _{IN} > 13.2 V	16	20	24	Α
t _{CL_REG}	CL Duration before SD (Note 9)		200	250	300	μS

ELECTRICAL CHARACTERISTICS (Typical values are at $T_J = 25^{\circ}C$, VIN = VINF = 12.0 V, $V_{ON} = 3.3$ V, $C_{VINF} = 0.1$ μ F, $C_{VDD} = 4.7$ μ F, $C_{SS} = 100$ nF. Min/Max values are valid for 6 V \leq VIN \leq 18 V, $-40^{\circ}C \leq T_J \leq +125^{\circ}C$, unless otherwise noted.) (continued)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OCP PROTECTI	ON					
OCP Threshold						
I _{OCP}	Over Current Detection Programmable Range		10	_	80	Α
I _{OCP_HYS}	Over Current Hysteresis – Percentage of Threshold		75	80	85	%
OCP _{Accuracy}	Over Current Detection Accuracy	VIN = 12 V, OCPx = 10 A	-10	-	+12	%
		VIN = 12 V, OCPx = 15 to 80 A	-10	-	+10	1
Timeout Delay						
OCP _{Timer}	Over Current Debounce Timer Range		0.25	-	50	ms
OCP _{Accuracy}	Over Current Debounce Timer Accuracy		-10	_	+10	%
OCP _{Reset-Timer}	Over Current Debounce Timer Reset		90	100	110	μs
SHORT CIRCUIT	PROTECTION					
I _{SC}	Short Circuit Current Threshold (Note 9)		135	150	165	Α
t _{SC}	Response Time (Note 9)	From I _{OUT} > I _{LIMSC} until gate pulldown	-	-	2000	ns
THERMAL PRO	FECTION					
T _{OT_F}	Programmable Over-Temperature Fault Threshold Range		80	_	150	°C
	Resolution		-	0.5	_	
	Default Setting		-	140	-	
T _{OT_W}	Programmable Over-Temperature Warning Threshold Range		70	_	150	°C
	Resolution		_	0.5	_	
	Default Setting		-	120	_	
OUTPUT SWITC	H (FET)					
R _{DS_ON}	Rdson Resistance	$V_{IN} = 6 \text{ V to } 18 \text{ V}, I_{LOAD} = 8 \text{ A}$	-	0.65	1.3	mΩ
I _{ds_OFF}	Off-state leakage current	$V_{IN} = 18 \text{ V}, V_{ON} < 1.0 \text{ V}, T_{J} = 25^{\circ}\text{C}$	-	-	1	μΑ
FAULT DETECT	ION					
VG_TH	VG Low Threshold	Latch/Restart if $V_{GS} < V_{G_TH}$ after t_{SS_FLT} , V_{IN} = 12 V	5.2	5.5	5.8	V
VDS_TH	VDS Short Threshold	Startup postpones if $V_{OUT} > V_{DS_TH}$ at $V_{ON} > V_{SWON}$ transition, $V_{IN} = 12 \text{ V}$	85	90	95	% VIN
VDS_OK	VDS Short OK Threshold	Startup resumes if V _{OUT} < V _{DS_OK} Threshold, V _{IN} = 12 V	65	70	75	% VIN
VDG_TH	VGD Short Threshold	Startup postpones if $V_G > V_{DG_TH}$ at $V_{ON} > V_{SWON}$ transition, $V_{IN} = 12 \text{ V}$	2.5	3.0	3.6	V
VDG_OK	VGD Short OK Threshold	Startup resumes if $V_G < V_{DG_OK}$, $V_{IN} = 12 \text{ V}$	2.1	2.6	3.2	V
V _{OUTL_TH}	VOUT Low Threshold	Latch/Restart if V _{OUT} < V _{OUTL_TH} after t _{SS_FLT} , V _{IN} = 12 V	85	90	95	% VIN
t _{SS_FLT}	Startup Timer Failsafe (Note 9)	V _{IN} = 12 V	180	200	220	ms
AUTO_RETRY						
t _{DLY_RETRY}	Auto-Retry Delay (Note 9)	VIN = 12 V, IOUT = 1 A	700	1000	1300	ms
VIN OVP				•		•
VIN _{OVP_LO}	Programmable Over Voltage Range	V _{ON} = 2 V, IOUT = 1 A	6	-	8	V
VIN _{OVP HI}	1		14	-	19	V

ELECTRICAL CHARACTERISTICS (Typical values are at $T_J = 25^{\circ}C$, VIN = VINF = 12.0 V, $V_{ON} = 3.3$ V, $C_{VINF} = 0.1$ μ F, $C_{VDD} = 4.7$ μ F, $C_{SS} = 100$ nF. Min/Max values are valid for 6 V \leq VIN \leq 18 V, $-40^{\circ}C \leq T_J \leq +125^{\circ}C$, unless otherwise noted.) (continued)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
VIN OVP						
VIN _{OVP_ACC}	VIN OVP Accuracy	6-8 V	-5	_	+5	%
_		14–19 V	-3	_	+3	%
VIN _{OVP_DFLT}	Default VIN OVP Setting		-	14.0	_	V
VIN UVLO			-	8		
VIN _{UVLO_ThF}	VIN Under Voltage Lock-out Falling Threshold	No Load	4.40	4.55	4.70	V
VIN _{UVLO_Hys}	VIN Under Voltage Lock-out Hysteresis		75	100	125	mV
VTEMP		•	•			
V _{VTEMP25}	VTEMP Pin Voltage at 25°C	T _J = 25°C	410	420	430	mV
A _{VTEMP}	VTEMP Pin Gain Per °C (Note 9)	25°C ≤ T _J ≤ 150°C	7.0	7.8	8.6	mV/°
	AND PERFORMANCE				ı	
F _{SCL}	Clock Frequency Range		10	_	400	kHz
V _{IH}	SDA and SCL Logic High threshold		1.35	_	_	V
V _{IL}	SDA and SCL Logic Low threshold		_	_	0.8	V
V _{HYS}	Logic Input Hysteresis threshold		80	_	_	mV
I _{Bias}	Logic Input Bias Current		-1	_	+1	μΑ
V _{OL}	SDA Output Logic Low Voltage	ISDA = 6 mA (Sink)	_	_	0.4	V
Ci	SDA and SCL Input Capacitance	, ,	_	_	10	pF
tR	SDA and SCL Rise Time		120	_		ns
tF	SDA and SCL Fall Time		100	_	300	ns
tSU;DAT	Data Setup Time		100	_	_	ns
tVD;DAT	Data Valid Time		0	_	_	ns
t _{HIGH}	SCL HIGH Time		0.6	_	50	μS
tLOW	SCL LOW Period		1.3	_	_	μs
t _{TIMEOUT}	Detect Low Time-Out		25	_	35	ms
tBUF	Bus-Free Time between STOP and START Conditions		_	1.3	-	μs
tSU;STA	Repeated START Setup Time		_	0.6	_	μs
tHD;STA	START or Repeated START Hold Time		_	0.6	_	μS
t _{LOW:MEXT}	Cumulative Clock Low Extended Time (Master Device)		_	-	10	ms
t _{LOW:SEXT}	Cumulative Low Extended Time (Slave Device)		-	-	25	ms
MASTER/SLAVE	FAULTS (FAULT#_C, FAULT#_D PINS)					
V _{FLT_IL}	FAULT#_x Active Low Input		_	_	0.4	V
V _{FLT_IH}	FAULT#_x Active High Input		3.2	_	_	1
R _{FLT_Rup}	Pull-up Resistance on FAULT#_x		300	450	700	Ω
R _{FLT Rdwn}	Pull-down Resistance on FAULT#_x		5.0	10	15	1
ALERT#						-
I _{ALT_HI}	Leakage Current into ALERT# Pin	ALERT# state is "High" and tied to, VIN = 12 V	-	_	1	μΑ
V _{AL LO}	Low Output Voltage	I_ALERT# = -1 mA, VIN = 12 V	_	_	0.3	V
POWERGOOD			1	•	1	
I _{LKG_PG}	Leakage Current into PG Pin	PG state is "High" and tied to VDD, VIN = 12 V	-	_	1	μΑ

ELECTRICAL CHARACTERISTICS (Typical values are at $T_J = 25^{\circ}C$, VIN = VINF = 12.0 V, $V_{ON} = 3.3$ V, $C_{VINF} = 0.1$ μ F, $C_{VDD} = 4.7$ μ F, $C_{SS} = 100$ nF. Min/Max values are valid for 6 V \leq VIN \leq 18 V, $-40^{\circ}C \leq T_J \leq +125^{\circ}C$, unless otherwise noted.) (continued)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
POWERGOOD						
V _{PG_LO}	Low Output Voltage	I_PG = -1 mA, VIN = 12 V	_	-	0.3	V
TELEMETRY			•			
T_TLMR	Period for all ADC Input Channels to be Measured		_	120	132	μS
VIN			•			
VIN _{MON}	VIN Measurement Range	No Load, MOSFET Enabled	6.0	_	19	V
	Accuracy	VIN = 6 V, No Load, T _J = 25°C (Note 10)	-2.5	-	+2.5	%
		12 V ≤ VIN ≤ 18 V, No Load, T _J = 25°C (Note 10)	-1.25	=	+1.25	
	Resolution	$6 \text{ V} \le \text{VIN} \le 19 \text{ V}$, No Load	_	31.25	_	mV
VOUT						
VOUT _{MON}	VOUT Measurement Range	No Load, MOSFET Enabled	6.0	-	19	V
	Accuracy	VOUT = 6 V, No Load, MOSFET ON, T _J = 25°C (Note 10)	-2.5	_	+2.5	%
		$ \begin{array}{c} 12~V \leq VOUT \leq 18~V,~No~Load,\\ MOSFET~ON,~T_J = 25^{\circ}C~(Note~10) \end{array} $	-1.25	_	+1.25	
	Resolution	6 V ≤ VOUT ≤ 19 V, No Load	_	31.25	_	mV
IOUT	•					
IOUT _{MON}	Output Current Measurement Range		0	=	127.87 5	А
	Accuracy	IOUT = 8 A, VIN = 12 V, T _J = 25°C (Note 10)	-14	=	+6.5	%
		$15 \text{ A} \le \text{IOUT} \le 80 \text{ A, VIN} = 12 \text{ V,} \\ T_J = 25^{\circ}\text{C (Notes 9, 10)}$	-7.5	-	+3.5	
	Resolution		_	125		mA
INTERNAL TEM	IP					
VTEMP _{MON}	Temperature Monitoring Range		-20	_	160	°C
	Accuracy	−20 < T _J < 125°C (Note 10)	-3	-	+3	°C
	High Temp Accuracy	125 ≤ T _J ≤ 160°C (Note 10)	-3	-	+3	°C
	Resolution		-	0.5	-	°C
SYSTEM TEMP	(VTEMP)					
VTEMP _{SYS_MON}	Temperature Monitoring Range		-20	_	160	°C
_	Accuracy	-20 < T _J < 125°C (Note 10)	-3	-	+3	°C
	High Temp Accuracy	125 ≤ T _J ≤ 160°C (Note 10)	-3	-	+3	°C
	Resolution		_	0.5	_	
OUTPUT PULL	DOWN					
R _{OUT_PD}	Output Pulldown Resistance	V _{OUT} = 12 V, PD mode = 1	600	1000	2200	Ω
_	io porformanco is indicated in the Flootrica		· .			

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Guaranteed by design or characterization data. Not tested in production.
 Min/Max Telemetry values are the combined errors of sense circuitry and ADC conversion errors.

TYPICAL CHARACTERISTICS

 $(VIN = VINF = 12~V,~C_{VINF} = 0.1~\mu\text{F},~C_{VDD} = 4.7~\mu\text{F},~C_{SS} = 220~n\text{F},~C_{OUT} = 100~\mu\text{F},~T_{A} = 25^{\circ}\text{C},~UNLESS~OTHERWISE~SPECIFIED)$

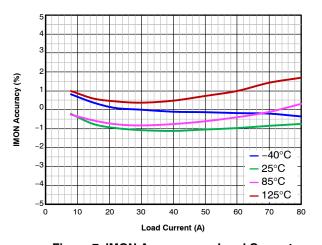


Figure 7. IMON Accuracy vs. Load Current and Temperature

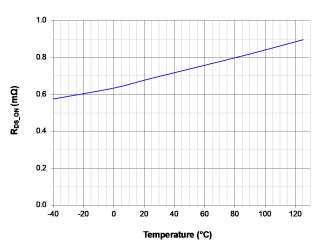


Figure 8. Switch RDS_ON @ 8 A vs. Temperature

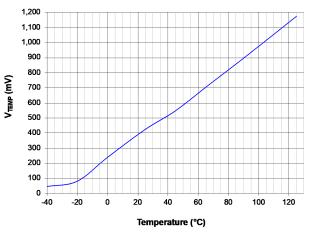


Figure 9. VTEMP vs. Temperature

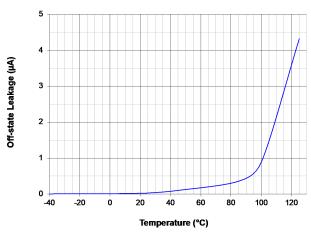


Figure 10. Switch Off-State Leakage vs. Temperature

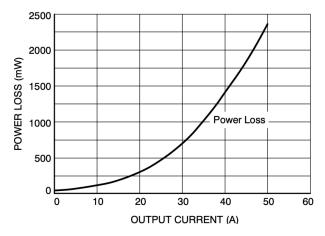


Figure 11. Power Loss vs. Current

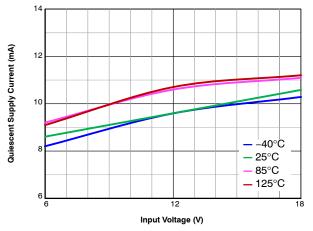


Figure 12. Quiescent Current vs. Temperature

TYPICAL CHARACTERISTICS (CONTINUED)

(VIN = VINF = 12 V, C_{VINF} = 0.1 μ F, C_{VDD} = 4.7 μ F, C_{SS} = 220 nF, C_{OUT} = 100 μ F, T_A = 25°C, UNLESS OTHERWISE SPECIFIED)

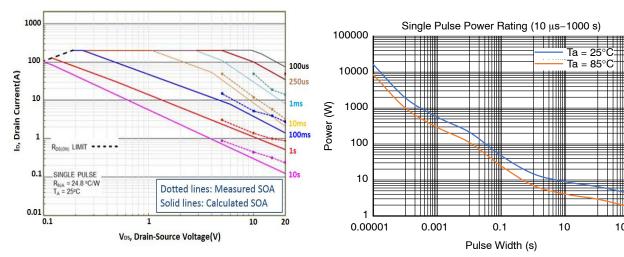


Figure 13. Power FETs Safe Operating Area



1000

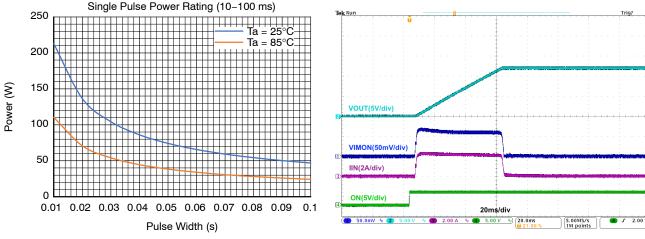


Figure 15. Single Pulse Power Rating (10 ms to 100 ms, Junction to Ambient, Note 6)

Figure 16. Start-up by ON, IOUT = 0 A, COUT = 10 mF

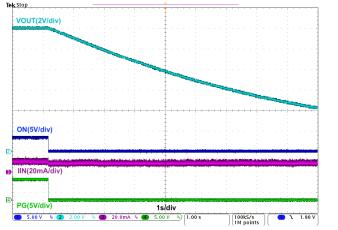


Figure 17. Shutdown by ON, IOUT = 0 A, COUT = 10 mF, Output Pulldown Enabled

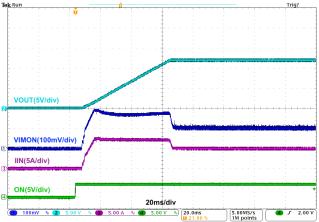
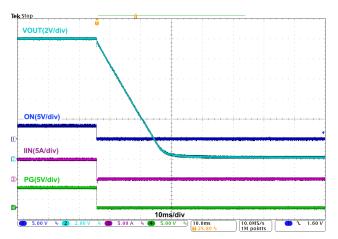


Figure 18. Start-up by ON, IOUT = 5 A, COUT = 10 mF

TYPICAL CHARACTERISTICS (CONTINUED)

 $(VIN = VINF = 12~V,~C_{VINF} = 0.1~\mu\text{F},~C_{VDD} = 4.7~\mu\text{F},~C_{SS} = 220~n\text{F},~C_{OUT} = 100~\mu\text{F},~T_{A} = 25^{\circ}\text{C},~UNLESS~OTHERWISE~SPECIFIED)$



VIN(2V/div)
VOUT(2V/div)

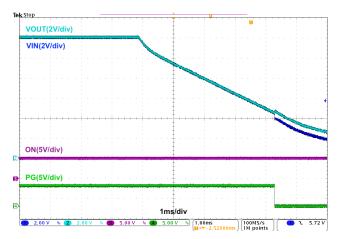
IIN(2A/div)
PG(5V/div)

20ms/div
2.000 V 2.000 V 2.000 N 5.000 N 6.0000 S (5.0000 S)

(10.000 S (2.000 N 5.000 N 5)
(10.000 S (2.000 N 5)
(10.000 N

Figure 19. Shutdown by ON, IOUT = 5 A, COUT = 10 mF

Figure 20. Start-up by VIN, IOUT = 0 A, COUT = 10 mF



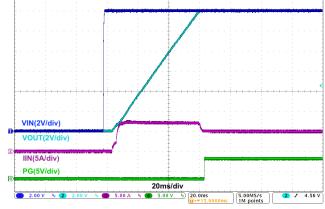
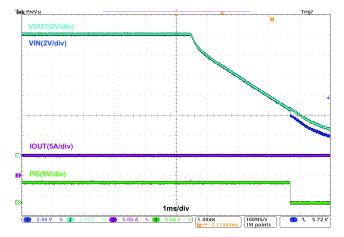


Figure 21. Shut-down by VIN, IOUT = 0 A, COUT = 10 mF

Figure 22. Start-up by VIN, IOUT = 5 A, COUT = 10 mF



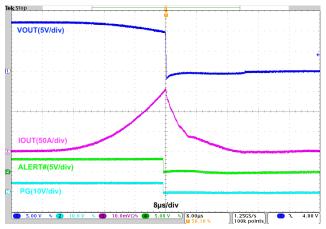


Figure 23. Shut-down by VIN, IOUT = 5 A, COUT = 10 mF

Figure 24. Short Circuit During Normal Operation, Initial IOUT = 0 A

TYPICAL CHARACTERISTICS (CONTINUED)

 $(VIN = VINF = 12~V,~C_{VINF} = 0.1~\mu\text{F},~C_{VDD} = 4.7~\mu\text{F},~C_{SS} = 220~n\text{F},~C_{OUT} = 100~\mu\text{F},~T_{A} = 25^{\circ}\text{C},~UNLESS~OTHERWISE~SPECIFIED)$

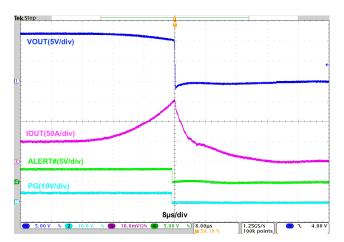


Figure 25. Short Circuit During Normal Operation, Initial IOUT = 50 A

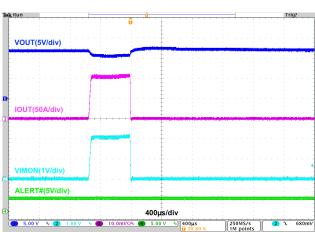


Figure 26. Over Current Protection During Normal Operation, OCP3 Level = 80 A, OCP3 Debounce Timer =1 ms, Load Pulse Width = 500 μs

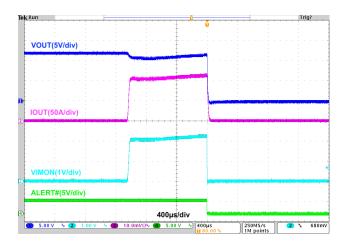


Figure 27. Over Current Protection During Normal Operation, OCP3 Level = 80 A, OCP3 Debounce Timer = 1 ms, Load Pulse Width = 1.5 ms

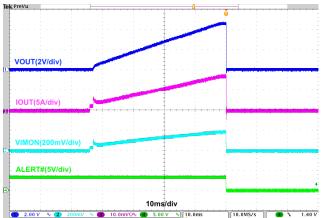


Figure 28. Over Current Protection During Softstart

DEFINITIONS

Definitions

The NCP81428 uses "Host", "Master" and "Slave" terminology when referring to the operation of the NCP81428's function in the application:

- A Host is the device which controls the PMBus
- A Master is an NCP81428 device that is a Slave to the Host, controls the NCP81428 Slaves' On/Off Operation and/or the Two Wire Interface (TWI) via FAULT#_C and FAULT#_D.
- A device referred to as a Slave is controlled by the NCP81428 Master for enablement, TWI communication and fault reporting.

Please refer to the Master/Slave configuration and the TWI sections for further information.

General Information

The NCP81428 is an electronically re-settable, fuse for use in server-based, high current 12 V hot-swap applications. The NCP81428 consists of a very low RDSon

NMOS pass device for minimal power dissipation and in using a copper clip leadframe improves heat transfer away from the power FET.

The device also contains a 10 bit ADC for accurate current, voltage and temperature measurements and the data is stored in user interface registers through the PMBus interface. The device also has two pins dedicated (Fault#_C and Fault#_D) for controlled start—up and shutdown between devices in parallel.

Additionally, the NCP81428 contains Non-Volatile Memory for storing user defined values for setting the Over-Current-Protection levels, the Over-temperature Fault Level and other parameters.

Initialization

Master and Slave Initialization

The diagram below is the State Machine for the operation of the Master and Slave Device.

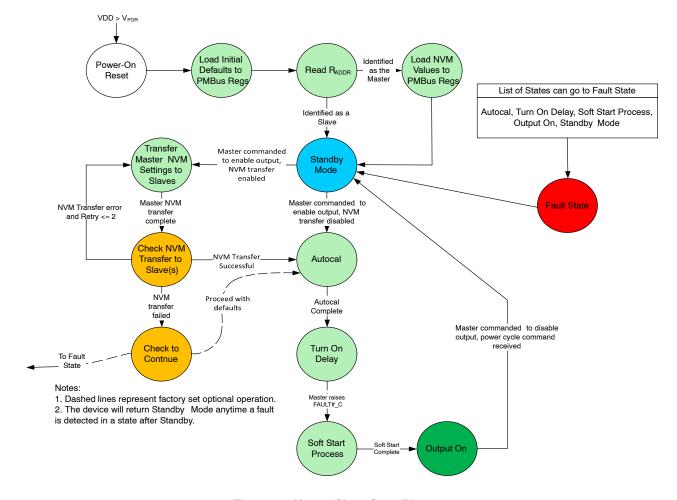


Figure 29. Master/Slave State Diagram

Master/Slave State Machine Simplified Breakdown

Upon applying power to the device, as the LDO output crosses the VDD UVLO threshold, the device's default values are transferred to the operating registers. Once the default values are loaded into the operating registers, the device reads the address resistor (R_{ADDR}). During the read of R_{ADDR}, the device determines whether it is connected to the PMBus, if it is a master (or single device) or a slave, and whether data transfer over the Two Wire Interface (TWI) will be utilized in parallel configurations.

Only masters will respond to its ON pin being driven high and/or the command through the PMBus to be enabled. Once in standby mode and the master is enabled, the devices can either proceed to Auto-Cal or start data transfer based on the ADDR resistor programmed configuration. If the master and slaves have data transfer enabled, FAULT# C and FAULT# D become CLK and SDA outputs from the master and inputs to the slaves only during data transfer. Once data is transferred, the slaves regain control over the FAULT# D pin and notify the master if there is data mismatch by asserting FAULT#_D low. In the event there is an error in the data transfer, the master will attempt to transfer the data 3 times. If after three failures to transfer, there is a factory setting to either proceed with the default values or shutdown. Once in Auto-Cal, a toN delay is built into the process to ensure the devices are ready before the Master simultaneously enables soft-start in itself and the slaves by asserting FAULT# C high. Note that there are four 8us consecutive FAULT# C pulses that occur during the initial soft-start stage for gate pre-charge and synchronization between master and slaves to ensure a current balanced soft-start.

With the exception of during data transfer, in all modes starting at standby, FAULT#_C is used for enabling all devices in parallel and signaling that the master has a fault and FAULT#_D is used for any slave to signal that it has a fault.

The user is highly recommended to send a STORE_USER_ALL command when the device is in stand-by mode and not during normal operation just as PMBus protocol suggests as this may result in unpredictable and even catastrophic results. Once the user is satisfied with their custom settings and a STORE_USER_ALL command is sent, the second time the device gets powered-up (VDD recycle) the user settings get stored in the operating memory replacing the manufacturer's PMBus default values.

Power-Up with VIN Release

Once the voltage at VDD rises above VDD UVLO threshold, the device's LDO is always on irrespective of output enable status (ON pin or enable via PMBus). The device will then proceed to reading the ADDR configuration

resistor and load the factory set default values to the operating registers. Note that during the power up sequence, the NCP81428 forces a current out the ADDR pin to produce a voltage across the address resistor connected to the pin. By measuring the voltage with the internal ADC, the device is able to determine whether the device is to behave as a master or slave; whether it is to communicate across the PMBus and if data transfer from the master and slave(s) are enabled (Refer to Master/Slave Configuration sections for details).

For the first 2 ms after the VDD UVLO is reached, PMBus commands to the device are blocked to prevent writing to registers before the default values are loaded. If commands to the device are sent during the 2 ms blanking period, the device will respond by setting the busy bit in registers 0x78 and 0x79 and assert ALERT# low. For this reason, it is recommended that any changes to control registers be performed 2 ms or more after the VDD UVLO occurs and prior to enabling the device. Additionally, in parallel configurations where data transfer is enabled, the device will blank PMBus commands for approximately 2 ms after the master is enabled. During this period, the master will attempt to transfer stored settings in the Non–Volatile Memory to the slaves.

In parallel configurations, after the first 2 ms blanking, if there are no faults present, the slaves release FAULT# D to high. If the system is configured for data transfer, this indicates to the master that the slaves are ready for the data transfer. Then when the master is enabled, FAULT# C goes high, and data transfer begins. During data transfer, FAULT# D and FAULT# C are configured as output signals (DATA, CLK) respectively from the master device and input signals to the slave. The masters sends a series of high frequency pulses on FAULT# D to initiate the data transfer while FAULT#_C is held high until the transfer Once data transmission is complete, begins. FAULT#_C and FAULT#_D pins on the master and slaves revert back to being Master and Slave fault indicators respectively. Then the master drives FAULT#_C high signaling the slaves to begin soft-start simultaneously with the master.

The plot below showcases a simplified parallel eFuse application power–up event with data transfer enabled. The master device detects a VIN Over–Voltage fault at the end of soft–start and asserts FAULT#_C to disable itself and the slaves. If a slave fault would have occurred instead, FAULT#_D asserts low alerting the Master device which in turn asserts FAULT#_C low, disabling all the NCP81428 devices simultaneously. Note that for a single device application, FAULT#_C and FAULT#_D are floating pins and data transfer is not applicable in such a case.

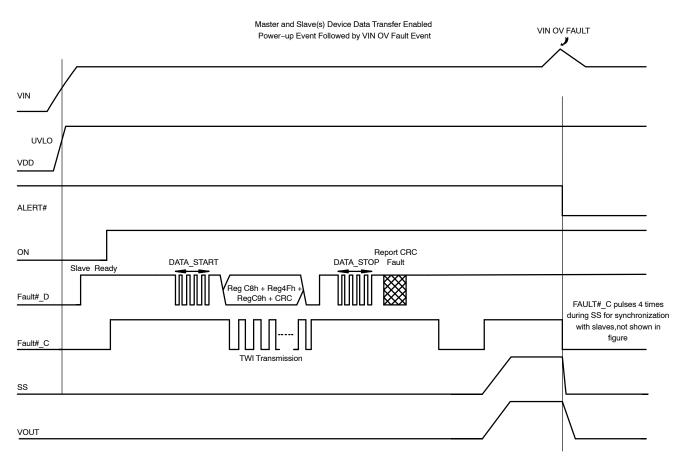


Figure 30. Data Transfer Sequence and VIN OV Fault

Simplified System Block Diagram

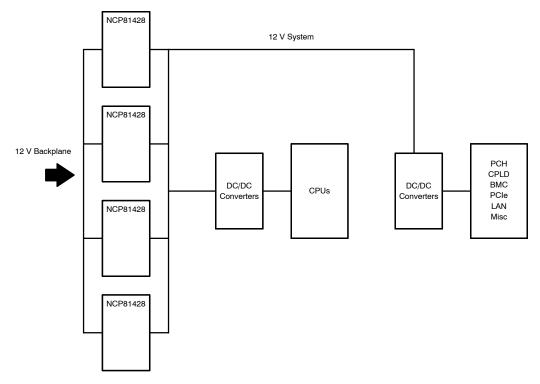


Figure 31. Simplified System Block Diagram

Configurations

eFuse System Configuration

The four system configurations below represent ways the NCP81428 can be configured. In the three Master/Slave

configurations (Sub Figures B, C and D), only one slave is represented, but up to six slaves can be connected with the master.

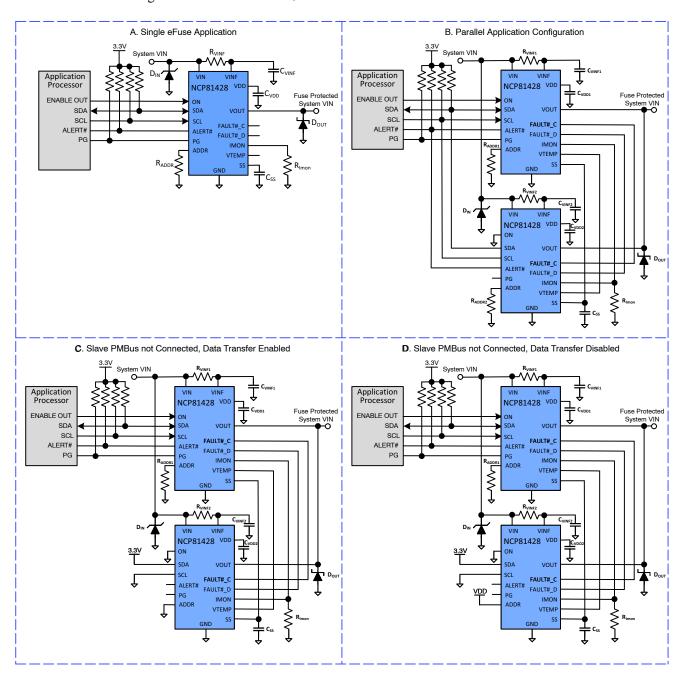


Figure 32. Four Possible PMBus and Data Transfer Configurations

Table 1. MASTER/SLAVE CONFIGURATIONS (Master enable Method: HW by asserting the ON pin high; SW by Software command)

	Description	Enable Method	PMBus	TWI	ADDR Pin Resistor
1	Single Device	ON and/or SW	Yes	No	20.0K NVM Data Transfer Disabled
2	Master	ON and/or SW	Yes	Only for Fault Communication	9.31K,14.3K NVM Data Transfer Enabled 20.0K NVM Data Transfer Disabled
	Single or Multiple Slaves	FAULT#_C pulled up by Master	Yes		26.7K to 73.2K NVM Data Transfer Enabled 86.6K to 182K NVM Data Transfer Disabled (Refer to ADDR pin Configuration for details)
	Single or Multiple Slaves		No		Pulled to VDD (NVM Data Transfer Disabled) Shorted to GND (NVM Data Transfer Enabled)

^{11.} NVM will be blank the very first time the device turns on. The device will populate the manufacturer's default settings the first time it powers-up. Once the user programs and sends a STORE_USER_ALL Command, all the user programmable PMBus registers will be stored in the NVM so that on the next power-up event the user settings will be loaded onto the operating memory. Once that procedure is complete, it is imperative not to alter the operating memory's data prior to enabling the device as that will lead to discrepancies between what was stored in the NVM and what will be transferred during TWI if any of the transferable bits get changed. Refer to the simplified State Machine Diagram for details.

Slave w/o PMBus Configuration

The NCP81428 provides the capability to designate one device as the master with up to 6 other devices designated as slaves in parallel. With the NCP81428 having its own TWI communication, the Master can provide over-current, over-temperature protection and base address settings to the slaves from the Master's on-board, non-volatile memory (NVM). Additionally, if any slave in the system identifies a fault, the slave will alert the Master device by pulling FAULT#_D low. Upon capturing a FAULT#_D logic low the master forces FAULT#_C low to turn itself and all the slaves off. Utilizing the TWI bus features, communication and control can be entirely between the system's application processor and the Master eFuse. This reduces the complexity and host activity for parallel eFuse applications.

Please refer to Figure 32C, PMBus Not Connected, Data Transfer Enabled. Tying the slave's ADDR pin to ground disables PMBus communications and enables the NVM data transfer. When power is applied to the Slave and no LDO faults are detected on either master or slave(s) and the LDO outputs have settled, POR is generated, manufacturer's default register values are populated. As the device gets enabled, the Master's NVM registers C8h, C9h, 4Fh registers get transferred to all the slaves simultaneously via the FAULT# C and FAULT# D pins. Note that copying the Master's NVM register data to the slaves is repeated every time the devices recover from a fault or power is removed and reapplied. The user must not alter the operating memory prior to enabling the device as that would cause a mismatch between what was written in the NVM and what gets transferred during the TWI process. Once the data transfer is complete, both the Master and the Slaves reconfigure their TWI bus pins to be a 2-wire fault notification system.

Please refer to Figure 32D, PMBus Not Connected, Data Transfer Disabled. Tying the slave's ADDR pin to VDD disables both PMBus communications and the NVM data transfer. Once the master is enabled, the devices progress straight to Auto-Cal. And after the t_{ON} delay, the master drives the FAULT# C high and soft-start begins.

Note that in configurations where the slave(s) are not connected to the PMBus, the ALERT# pin driver is disabled on the slave(s). However a fault event among a slave will be relayed to the master via FAULT#_D which in turn asserts ALERT# to notify the host and FAULT#_C low to disable all of the eFuses simultaneously.

Slave w/ PMBus Configuration

Please refer to Figure 32B, PMBus Connected W/ and W/O Data Transfer.

In parallel applications, a master/slave that are on the PMBus have to be configured as shown in the ADDR pin configurations table (Table 6) in order to enable or disable TWI data transfer.

The ALERT# pins of the master and each slave are tied together and to the system's application processor (Host). This way, any master or slave warning or fault will result in the device pulling the ALERT# low to notify the Host per PMBus standards. Additionally, any condition which results in the Master or a Slave to shut off its output, will result in the Master pulling down on the PG pin. An example of both ALERT# and PG being pulled down is an OCP condition. As soon as the Master recognizes an over current condition, it starts the debounce timer defined in register C9h. If the Over–Current still exists at the end of the timer, ALERT# goes low (if not masked) and FAULT#_C asserts low disabling the master and slave device(s) simultaneously, PG asserts low and Vout discharges.

When the master's 0xC9 register has been configured for Retry and a Slave has faulted, in order to identify the fault, the Slave's Status registers need to be polled within 125 ms of the Alert# going low in order to capture the source of the fault before the slave registers are reset upon the Master re–enabling the devices by asserting FAULT# C high.

Another possible configuration is enabling TWI data transfer while a slave is on the PMBus.

Refer to the ADDR pin configurations table (Table 6) for selecting the proper resistor values for both master and slave devices. In order to alleviate PMBus write transactions among multiple devices on the board, the TWI interface allows the master constants in regC8h, 4Fh and C9h to be transferred to the slaves. The user simply stores the Master's operating memory in the master device's NVM using the Store_User_All command and on the next power cycle, the master transfers the aforementioned registers to the slaves. Then the slaves only need to be addressed for telemetry readback and cases of a faults or warnings.

Inputs/Outputs

VDD Output (Auxiliary Regulated Supply)

An internal linear regulator draws current from the VINF pin to produce and regulate the voltage at the VDD pin. This auxiliary output supply is current limited to I_{DD_CL} . A 4.7 μF ceramic capacitor must be placed between the VDD and GND pins and as close as possible to the NCP81428. The voltage difference between the VIN and VINF pin voltage should be within 0.4 V for adequate IMON performance. A small time constant R/C filter such as 1 $\Omega/0.1~\mu F$ on the VINF pin is recommended. The VDD pin is intended to power internal circuitry in the NCP81428. Do not connect any load to the VDD pin. Doing so, may result in erratic behavior.

Single Device Sequence

When the ON pin voltage is higher than V_{SWON} and no Under-voltage (UVLO) or output switch faults are present, SS begins after the t_{ON} timer set by the device. To ensure consistent behavior, a weak internal 1 M Ω pull down resistor holds the pin low if the pin is left floating and 100 mV of hysteresis reduces the likelihood of chatter.

Simplified Parallel Configuration Enabling and Soft-Start Synchronization Diagram

When the VON > V_{SWON}, no UVLO or output switch faults are present and FAULT#_D is driven high, depending on ADDR configuration, TWI data transfer will or will not occur. Once the t_{ON} timer elapses, the master device initiates the SS sequence by enabling itself and the slaves with three 8 μs FAULT#_C logic high pulses which pre-charge the gate, synchronize the devices to current share adequately, check for output short conditions and gear up for the main soft-start with a fourth logic high on FAULT#_C. The Figure 33 showcases how the slave releases FAULT#_D line to indicate readiness for the master and upon receiving a logic high on the ON pin the master pulls up the FAULT#_C. Various state machine transitions were skipped as depicted by the dashed lines since this plot concentrates on enablement and soft-start sequencing.

SS Output (Soft Start)

When the power switch first turns on, it does so in a controlled manner. The output voltage (VOUT) follows the voltage at the SS pin, produced by current I_{SS} into a capacitor (Css). In parallel eFuse applications, the SS pins of all fuses should be shorted together to one shared SS capacitor, note that only the master device will source out the $5\,\mu\text{A}$ current to initiate soft–start. The internal soft–start load

balancing circuitry will ensure the soft-start currents are evened out among the NCP81428 devices so that it doesn't put stress on one device over another or cause a soft start-current limiting event.

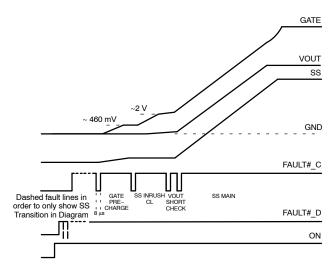


Figure 33. Soft Start Signals

The soft-start capacitor value can be calculated by the following equation: $CSS = (t_{SS} \times I_{SS} \times AV_{SS}) / VIN$ (where t_{SS} is the target soft-start time and the recommended range is 10–110 ms).

The typical C_{SS} values for different t_{SS} are approximated below for 12 V VIN.

The calculated soft-start times in Table 2 reflect the time when VOUT begins charging up from ground level to VIN. This does not include the gate pre-charge and synchronization delays before the main soft-start event.

Table 2. SOFT START PROGRAMMING CAPACITOR

T _{SS} (ms)	C _{SS} (nF)
12	47
20	82
29	120
43	180
52	220
64	270
78	330
110	470

The maximum load capacitor value NCP81428 can power up depends on the device soft–start time.

IMON Output (Current Monitor)

The IMON pin sources a current that is A_{IMON} (10 $\mu A/A$) times the VOUT output current. A 2 $k\Omega$ resistor connected from the IMON pin to ground must be used to monitor current information as a voltage up to V_{IMON_CLMP} A 100 nF capacitor can be used to low–pass filter the IMON

signal without affecting the internal operation of the device. In parallel applications, the IMON pins of all eFuses should be tied together. Connect a 2 k Ω resistor from the IMON pin of each eFuse to the ground. The total equivalent IMON resistance would be 2 k Ω /#D, where #D is the number of eFuses in parallel. In order to simplify the BOM, one single R_{IMON} resistor with the value of 2 k Ω /#D can be used across all IMON pins and the ground.

VTEMP Pin

The VTEMP pin is a voltage output proportional to the device's temperature, with an offset voltage (420 mV at 25°C). The VTEMP output can source much more current than it can sink, so that if multiple VTEMP pins are connected together, the voltage of all VTEMP outputs will be driven to the voltage produced by the hottest NCP81428 device in the application. Note that in parallel of the device applications, register 0x8D represents the temperature being addressed through the PMBus, whereas register 0x6C represents the hottest device among the paralleled eFuses. In most cases when appropriate layout and proper component placement is followed, the eFuse die temperatures should be relatively close amongst the parallel devices. But if the die temperature indicated in register 0x6C becomes 20°C greater than that in the master's 0x8D register, the master's ALERT# signal will assert to notify the host that an eFuse is operating at a higher die temperature compared with the master and the dev temp warn bit will set.

Auto Retry and Latch-Off through PMBus

When the Retry_Latchoff bit in register C9(h) is set to 1, the NCP81428 enters auto-retry mode. In this mode under

certain fault conditions, the FET is turned off and a new soft-start procedure takes place. Between the fault and the new soft-start, there is a delay of t_{DLY_RETRY}. The protection features that cause an auto-retry event are:

- Over–Current Protection
- Soft-Start Current Limiting Fault
- Short-Circuit Detection
- Over-Temperature Fault
- Excessive Soft-Start Duration Violation
- VIN OV and VIN UV Faults
- VIN to GATE Short

A VIN to VOUT short condition is non-latching/non-auto-retry. If the device is disabled and VOUT > VDS_TH the device is prevented from powering up. The device is allowed to power up once VOUT < VDS_OK.

When the Retry_Latchoff bit is set to 0, the NCP81428 is in latch-off mode. If a fault occurs, the device remains off until either the ON pin is toggled or when VDD is recycled.

Note that the Retry_Latchoff bit is ignored in a slave device as the decision to restart is controlled solely by the master.

Data Transfer Sequencing

Figure 34 below represents the sequence of starting, transferring, checking, stopping and validation of the data transfer from the Master's NVM values to the slaves. During data transfer, the clock frequency will be a typical 400 kHz and the entire process will take approximately 120 µs.

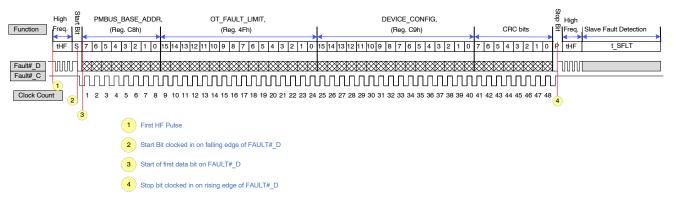


Figure 34. Master to Slave NVM Content Transfer Sequence

Warnings

Table 3. WARNINGS SUMMARY

Warning Type	Master/ Slave	ALERT#	FAULT#_C	FAULT#_D
VIN_OV	Master	Н	Н	Н
VIN_UV				
Over_Temperature	Master		Н	Н
	Slave			

In a Master/Slave Configuration, only the Master reports a VIN_OV or VIN_UV warning condition. If the user wishes to communicate with a slave device, then a valid resistor value should be selected to program the slave address. If no communication is necessary with the slaves, then connect the address pin(s) to ground. Note that in the case of no communication with PMBus on the slave, the alert pin driver gets disabled and ALERT# stays high all the time.

FAULT# C and FAULT# D Operation

FAULT#_C and FAULT#_D are used for initiating soft-start and proper sequencing but also for fault communication between master and slave devices. Under normal operating conditions FAULT#_C and FAULT#_D are set in the high state. The tables below summarize the master / slaves actions upon a fault condition.

Table 4. MASTER FAULT#_C AND FAULT#_D FAULT BEHAVIOR

Master Faults	FAULT#_C	FAULT#_D	Notes
SS Current Limit, VDD UVLO, FET Health, OCP, SCP, VIN UV/OV, OT	H to L	Н	Master FET health includes (VGS/ VDS/VGD and SS timer faults)
TWI Fault	*H to L	H to L	Three consecutive data transmission failures / CRC mismatch and Device configured to not continue when TWI fails

NOTE: In a Master/Slave system, only the master monitors VIN and VOUT related faults. As for a TWI related fault, only the master will set the twi_fault bit 2 in reg_0x80, STATUS_MFG_SPECIFIC register. Any fault_can_have_ALERT# masked_as described in register (1Bh) SMBALERT_MASK.

Table 5. SLAVE FAULT#_C AND FAULT#_D FAULT BEHAVIOR

Slave Faults	FAULT#_C	FAULT#_D	Notes
SS Current Limit, VDD UVLO, FET Health, OCP, SCP, OT**	*H to L	H to L	Slave FET health includes (VGS and VGD faults)

^{*}Represents a delayed signal on the master upon receiving a FAULT# D low from the slave

ADDR Pin Configuration

The NCP81428 offers various types of parallel configurations to select from based on the application's needs. In a master/slave configuration, the NCP81428 allows the user to choose to communicate with the slaves or not. The purpose of this is to reduce host activity by communicating with just the master device.

Table 6. ADDR PIN DEFINED CONFIGURATIONS

Device	R _{ADDR} (kΩ)	PMBus	Address	TWI Data Transfer
Master	9.31	YES	Base + 00h	Enabled
	14.3		Base + 01h	Enabled
	20.0		Base + 02h	Disabled
Slave	26.7	YES	Base + 03h	Enabled
	34.0		Base + 04h	Enabled
	42.2		Base + 05h	Enabled
	51.1		Base + 06h	Enabled
	61.9		Base + 07h	Enabled
	73.2		Base + 08h	Enabled
	86.6		Base + 09h	Disabled
	102.0		Base + 0Ah	Disabled
	118.0		Base + 0Bh	Disabled
	137.0		Base + 0Ch	Disabled
	158.0		Base + 0Dh	Disabled
	182.0		Base + 0Eh	Disabled
	Ground	NO	N/A	Enabled
	VDD			Disabled

PowerGood

The NCP81428 provides a dedicated PG pin to indicate that output voltage is within a range relative to the input voltage. The PG pin is an open drain signal that is held low during soft-start until the output voltage reaches approximately Vin and VGS > 6.3 V. Once those conditions are met, the PG pin will be released, the PG_STATUS# bit will clear as full load can be applied across the device. PG pin will assert low during fault events or when the NCP81428 is commanded by the host to be disabled (PG_STATUS# bit will set), but will remain high during warning events. During a thermal shutdown event, if the device is programmed for auto retry mode, the PG pin will be held low until the die temperature drops below the OT_WARN_LIMIT and tDLY_RETRY elapses, which prompts a new soft-start sequence.

PG can go high again upon meeting the conditions described above for VGS and VOUT.

Since PG is an open drain signal, it requires an external pull-up resistor (see Applications Diagrams).

^{**}Represents that a Slaves OT Fault range is from 120.5°C to 150°C. The Master is responsible for OT faults outside of this range.

12. A typical FAULT# D to FAULT# C delay is 500 ns.

IMON Peak

The IMON Peak detection circuit samples and holds the IMON voltage to represent the peak current value upon entering an OCP event. The peak current can be read in register 0xC4 which is a READ/CLEAR register. Once the register is read, it is automatically cleared. If not read and the device encounters a peak that is higher than the previous peak current captured by the device, then the later peak will be populated in the register replacing this former value. Toggling the ON pin does not clear this 0xC4 register, the device instead, holds the peak value until the register is read.

Protection Features

Current Limiting During Start-up

During startup, the NCP81428 current limits are dependent on a number of factors such as VIN and VOUT levels relative to VIN.

Table 7. FOR V_{IN} < 13.2 V

VOUT/VIN	I _{CSLO}
0 < VOUT < 0.4 x VIN	7.5 A (Typ)
0.4 x VIN < VOUT < 0.8 x VIN	15 A (Typ)
0.8 x VIN < VOUT < VOUT~VIN	30 A (Typ)

Table 8. FOR $V_{IN} > 13.2 \text{ V}$

VOUT/VIN	I _{CSHI}
0 < VOUT < 0.4 x VIN	5 A (Typ)
0.4 x VIN < VOUT < 0.8 x VIN	10 A (Typ)
0.8 x VIN < VOUT < VOUT~VIN	20 A (Typ)

As VOUT is approximately equal to VIN and PowerGood goes high the device stops current limiting and Over Current Protection becomes active.

If a current limiting condition exists anytime for a continuous duration > $t_{\rm CL_REG}$, then the device latches off. If the NCP81428 is programmed for auto-retry mode, then the device will try to softstart after the $t_{\rm DLY}$ RETRY elapses.

Soft Start Duration

If VOUT < V_{OUTL_TH} when t_{SS_FLT} expires, the NMOS FET latches—off or restarts based on the Retry_Latchoff bit setting. Note that a VGS fault (V_{GS} < VG_TH) can also cause an excessive soft–start duration fault. Both conditions have to be met at t_{SS_FLT} , otherwise a fault will occur.

Short Circuit Detection

The NCP81428 contains a high-bandwidth current sense SCP amplifier monitoring and rapidly responding to severe shorts which may cause irreparable damage. The fast current loop circuit allows the device to start pulling the gate low within the t_{SC} limit from the time it senses the fault. Once the Power FET turns off, it either is restarted or remains latched off depending on the bit setting set in the Retry_Latchoff

Register under Device Configuration. The short-circuit current threshold is fixed and not user programmable.

Over Current Protection

The NCP81428 provides three programmable levels of over current protection (OCP) in register 0xC9. OCP1 provides the lowest current range while OCP3 allows up to 80 A before the device determines an overcurrent condition.

OCP1 and OCP2 settings can work in parallel to provide a case where a longer timer can be used for OCP1 and a shorter timer for OCP2 such that the energy during a fault remains similar and below the SOA of the device for the application. If the current levels in OCP1 are not a concern for the application, set ocp1 level to 00b (None).

OCP3 is reserved for higher operating current applications. In order for the OCP3 level to work properly, both ocp1 level and ocp2 level should be set to 00b (None).

Each OCP level can be programmed for a debounce time of 0.25 to 50 ms to determine if the fault is valid. Reg. 0xC9 contains debounce (ocp1 delay, ocp2 delay, ocp3 delay). A reset timer is also implemented such that if the current level exceeds the OCP setting, but returns to a value below the hysteresis of the OCP threshold for a minimum of 100 us before the debounce timer expires, the debounce timer will reset. Expiration of the OCP debounce timer in a single device configuration will result in the device disabling the output. In a Master/Slave configuration, if an OCP debounce timer expires on a Slave, the Slave will pull FAULT# D low to signal the Master of a fault. In the case of the Master determining an OCP fault, it will pull FAULT# C low to disable the Slaves and itself.

Over Temperature Shutdown

The NCP81428 employs an internal thermal sensor for monitoring the die temperature. If the junction temperature surpasses the thermal warning threshold set in register OT WARN LIMIT (51h), the bit in the STATUS BYTE register sets. Upon surpassing the warning limit, the Host is notified to take the appropriate actions. If the Host does not respond to the temperature warning event, as the junction temperature continues to rise when it exceeds the thermal shutdown fault threshold set in OT FAULT LIMIT (4Fh) the device will shut off. After thermal shutdown, the NCP81428 recovery mode depends on the Retry Latchoff bit setting in Device Config. If retry mode is selected, when the die temperature falls below the OT WARN LIMIT, the device restarts. If programmed in latch-off mode, the device has to be re-enabled for a restart and will only restart after the temperature falls below OT WARN LIMIT. Note that if the OT_FAULT_LIMIT is set lower than or equal to the OT_WARN_LIMIT threshold, an invalid data fault sets.

FET Fault Detection (FET Health)

The device contains various FET monitoring circuits:

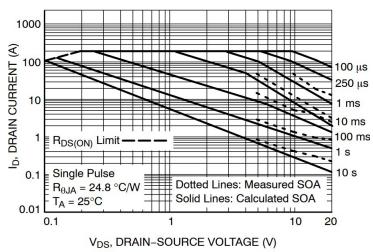
- VIN to VOUT short, non-latching/non-auto-retry condition. If the device is disabled and VOUT > V_{DS_TH} , then ALERT# is pulled low and the device is prevented from powering up. The device is allowed to power up once VOUT < V_{DS_OK} .
- GATE to VIN short, latching/auto-retry condition. If the device is disabled and V_{GATE} (Pin 8) > V_{DG_TH}, then ALERT# is pulled low and device latches/auto-retries.
- GATE leakage, If (V_{GATE} VINF) < V_{G_TH} after t_{SS_FLT}, then ALERT# is pulled low and the device latches/auto-retries.

Note that only the master monitors a VIN to VOUT short. Whereas the other two faults mentioned above are monitored across both master and slave. FAULT#_C and FAULT#_D will pull low depending on the offending

device. For instance, a slave device experiences a gate leakage at t_{SS_FLT} then it will assert FAULT#_D alerting the master which in turn asserts FAULT#_C to disable itself and the slave(s) simultaneously.

FET SOA Limits

The NCP81428 has built-in current limits and fault-monitoring circuits to ensure that the co-packaged NFET is always kept within SOA limits. The startup current limiting conditions adjust based on the input voltage levels as described in the electrical specifications table to ensure constant power across the device throughout the soft-start transition. Refer to the internal current sensing section for more details. Note that the NCP81428 does not limit the current during an OCP event, the powerFET is always in the linear region.



Internal FET's Safe Operating Area (SOA)

Figure 35. Power FET Safe Operating Curves

VIN OVP and UVP

The NCP81428 has a programmable VIN Over–Voltage Protection feature that allows the user to set the input over voltage fault threshold. The VIN_OV_FAULT_LIMIT in register (55h) has two data bytes encoded in linear11 format with 5 bits unsigned exponent and 11 bits mantissa. Refer to register 55h for range, resolution and programmability. The VIN_OV_FAULT thresholds are comparator based in order to respond swiftly to a fault whereas the VIN_OV_WARN thresholds are ADC based. The device also has a VIN under voltage protection feature that is fixed to 4.55 V (typ) rising with 0.10 V (typ) hysteresis.

GOK Bit

The GOK bit in the STATUS_MFR_SPECIFIC Register is meant to report faults under the following conditions:

- V_{ON} disabled and V_{DS_OK} is false (indicates a VIN to VOUT short) – the device is allowed to power–up when the short is cleared
- V_{ON} disabled and V_{GD_OK} is false (indicates a VIN to GATE short) – device latches off or auto-retries depending on latch_off_auto_retry_bit
- V_{ON} enabled and V_{SS_OK} is false at t_{SSF_END} (indicates either VOUT < 90%V_{IN} or V_{GS} below V_{G_TH} at the end of soft-start) device latches off or auto-retries depending on latch off auto retry bit

PMBus Address

PMBus Addressing

The NCP81428's PMBus Default Base Address is 0x64.

Table 9.

	Binary Address														
7	6	5	4	3	2	1	0								
1	1	0	0	1	0	0	R/W								

READ = 1 WRITE = 0

Refer to register (0xC8) for reprogramming the PMBus Base address selection. Note, care should be taken in parallel configurations to ensure no values are used which are not permitted by the SMBus standards.

Commands w/o PEC

The Send Byte transaction is used to send a simple command to the device. A send byte transaction transfers a command with no data. The CLEAR_FAULTS command is one example of a Send Byte command.

A start bit followed by the 7 bit slave address with a 0 (write) appended comprises the first stage of the transaction. If the slave ACKs the address, then the host sends the 8 bit command followed by a stop condition. A format example is shown below:

1	7	1	1	8	1	1
s	Slave Address	W	Α	Command Code	Α	Ρ

Send Byte

Figure 36. Send Byte

The Read Byte starts like a typical I²C write transaction by sending the slave address, plus write bit, followed by a 2nd byte containing the command code. Then repeated start (SR) is sent, followed by the slave address with read bit (1), requesting the slave device to return the data for the specified command code. The slave responds by transmitting the byte value requested.

1	7	1	1	8		1	7	1	1	8	1	1
s	Slave Address	W	Α	Command Code	Α	SR	Slave Address	R	Α	Data Byte	Ν	Р

Read Byte
Figure 37. Read Byte

The Read Word transaction also starts like a typical I²C write by sending the slave address, plus write bit. The 2nd byte contains the command code. Then repeated start is sent, followed by the slave address with read bit, signaling the device to return data for the specified command code. The slave responds by transmitting the value requested, low data byte first, followed by the high data byte, as illustrated below:

1	7	1	1	8	1	1	7	1	1	8	1	8	1	1
s	Slave Address	W	Α	Command Code	Α	SR	Slave Address	R	Α	Data Byte Low	Ν	Data Byte High	Ν	Ρ

Read Word

Figure 38. Read Word

The Write Byte transaction is used by the host to send a single byte of data to the device. The OPERATION command, used to configure the device operation, is an example of this type of transaction.

The transaction begins with a start bit followed by the 7 bit slave address with a 0 (write) appended as the 8th bit, the command byte followed by the data byte, as illustrated below:

1	7	1	1	8	1	8	1	1
s	Slave Address	W	Α	Command Code	Α	Data Byte	Α	Р

Write Byte

Figure 39. Write Byte

The Write Word transaction is used by the host to send a single word of data (2 bytes) to the device. The SMBALERT_MASK command is an example of this type of transaction.

Similar to the write command, the only difference is that after the low data byte's ACK (3rd ACK), the high data byte is sent in addition.

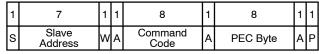
1	7	1	1	8	1	8	1	8	1	1
s	Slave Address	W	Α	Command Code	Α	Data Byte Low	Α	Data Byte High	Α	Р

Write Word

Figure 40. Write Word

Packing Error Checking (PEC)

PEC is an optional implementation in the PMBUS devices, but is highly recommended due to the critical nature of the data validity in power management systems. Packet Error Code bytes are generated using CRC–8 algorithm that is based on performing XOR operations on the input bit streams with a fixed CRC polynomial. The PEC byte is calculated on all bytes in the I²C transaction, including device address and read/write. PEC does not include start, stop, ACK/NACK or repeated state bits. Below are shown the Read and Write functions with the PEC byte included.



Send Byte with PEC

Figure 41. PEC Send Byte

1	7	1	1	8	1	1	7	1	1	8	1	8	1	1
s	Slave Address	W A Command Code					Slave Address	R	Α	Data Byte	Α	PEC Byte	N	Р
	Read Byte with PEC													

Figure 42. PEC Read Byte

1	7	1	1	8	1	1	7	7 1 1		8	1	8	1	8	1	1
s	Slave Address	V	Α	Command Code	Α	S _R	Slave Address			Data Byte Low	Α	Data Byte High	Α	PEC Byte	Ν	Ρ

Read Word with PEC

Figure 43. PEC Read Word

1	7	1	1	8	1	1	7	1	1	8	1	8	1	8	1	1
s	Slave Address	W	Α	Command Code	Α	SR	Slave Address	R	Α	Byte Count	Α	Data Byte	Α	PEC Byte	Ν	Ρ

Block Read with PEC

Figure 44. PEC Block Read

1	7	1	1	8	1	8	1	8	1	1
s	Slave Address	W	Α	Command Code	Α	Data Byte	Α	PEC Byte	Α	Р

Write Byte with PEC

Figure 45. PEC Write Byte

1	7	1	1	8	1	8	1	8	1	8	1	1
s	Slave Address	W	Α	Command Code	Α	Data Byte Low	Α	Data Byte High	Α	PEC Byte	Α	Ρ

Write Word with PEC

Figure 46. PEC Write Word

1	7	1	1	8	1	8	1	8	1	8	1	1
s	Slave Address	W	Α	Command Code	Α	Byte Count (01h)	Α	Data Byte	Α	PEC Byte	Α	Ρ

Block Write with PEC

Figure 47. PEC Block Write

Data Byte Format

Various NCP81428 commands utilize different data byte encoding to accommodate negative numeric values, step size, and range supporting DAC and ADC values.

The type used is designated individually for each register of the PMBus COMMAND DETAILS section of this document.

Linear11 format

The Linear11 format consists of 5-bit, 2's complement integer exponent and 11 bit linear mantissa, shown below:

		Dat	а Ву	/te ⊦	ligh					Dat	a B	yte L	_ow				
7	7 6 5 4 3 2 1 0								7 6 5 4 3 2 1								
	Exponent (N)							Man	tissa	a (Y)							

LINEAR11 Format

Figure 48. Linear11 Format

The exponent value is a fixed binary value, positive or negative, which typically determines step size or resolution for a given command. The mantissa is an 11-bit 2's complement integer typically establishing the range and be selective limited to discrete values.

The integer (1) of the data byte in LINEAR11 format can be calculated using:

$$I = Y \times 2^{N} \tag{eq. 1}$$

where: Y is a 2's complement integer from the mantissa and N is the 2's complement integer of the exponent

ULinear16 Format

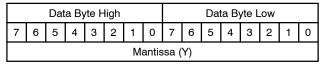
In the NCP81428 only the linear mode is supported. The VOUT_MODE bits are set to *X00b*. VOUT_MODE DATA BYTE:



Linear Mode

Figure 49. VOUT MODE Linear Format

This establishes the 5-bit 2's complement exponent for the 16 bit mantissa delivered as data bytes for an output voltage related command.



ULINEAR16 Format

Figure 50. ULinear16 Format

The integer (V) of the full data byte in ULINEAR16 format can be calculated using:

$$V = Y \times 2^{N}$$
 (eq. 2)

where: Y is a 16-bit unsigned binary integer from the mantissa and N is the 2's complement integer of the exponent

PMBus Commands

Commands

Table 10. PMBus COMMANDS LIST

Command Code	Command Name	SMBus Transaction Type: Writing Data	SMBus Transaction Type: Reading Data	Number of Data Bytes	NVM	TWI	Description
01h	OPERATION	Write Byte	Read Byte	1	YES	NO	See Registers Specifications Section
02h	ON_OFF_CONFIG	Write Byte	Read Byte	1	YES	NO	See Registers Specifications Section
03h	CLEAR_FAULTS	Send Byte	N/A	0	NO	SO	This command is used to clear all fault bits that have been set in the status register simultaneously and releases the ALERT#. CLEAR_FAULTS will not restart a device that has latched-off due to a fault condition. A latched-off device will remain off until: • Removing and then restoring VDD bias power. Device will restart in its default state. Fault bits are cleared when VDD < VDD_UVF threshold. • Faults are also cleared based on the turn on settings established by the ON_OFF_CONFIG: If ON is used for turn on, the faults are cleared when ON goes low. If soft enable is used for turn on, faults are cleared when OPERATION [7] is set to 0. If soft enable and the EN pin are both used for turn on, faults are cleared when OPERATION [7] and ON are both low. If fault conditions persists after the fault bit is cleared, the fault bit shall immediately be set again with the host notified via the ALERT# signal. NOTE: Any or all fault bits in any register except STATUS_BYTE and STATUS_WORD can be directly cleared by issuing the status command with 1 binary data byte. The binary data byte bits align with the corresponding status register bits. To clear fault bits, write a 1 to the corresponding bit in the binary data byte.
0Ch	ARA	Send Byte	N/A	0	NO	NO	The host sends an Alert Response Address (ARA) command to determine which device on the PMBus generated the alert signal. If more than one device pulls SMBALERT# low, the highest priority (lowest address) device will win communication rights via standard arbitration during the slave address transfer.
10h	WRITE_PROTECT	Write Byte	Read Byte	1	YES	NO	See Registers Specifications Section
15h	STORE_USER_ALL	Send Byte	N/A	0	NO	NO	The STORE_USER_ALL command instructs the PMBus device to copy the entire contents of the Operating Memory to the matching locations in the non-volatile User Store memory. Any items in Operating Memory that do not have matching locations in the User Store are ignored.

Table 10. PMBus COMMANDS LIST (continued)

Command Code	Command Name	SMBus Transaction Type: Writing Data	SMBus Transaction Type: Reading Data	Number of Data Bytes	NVM	TWI	Description
16h	RESTORE_USER_ALL	Send Byte	N/A	0	NO	NO	The RESTORE_USER_ALL command instructs the PMBus device to copy the entire contents of the non-volatile User Store memory to the matching locations in the Operating Memory. Any items in Non-Volatile Memory that do not have matching locations in the operating memory are ignored. It is recommended to wait at least 10 ms after STORE_USER_ALL command is sent before a RESTORE_USER_ALL or a second STORE_USER_ALL is sent.
19h	CAPABILITY	N/A	Read Byte	1	NO	NO	See Registers Specifications Section
1Bh	SMBALERT_MASK	Write Word	Read Byte	2	NO	NO	See Registers Specifications Section
20h	VOUT_MODE	N/A	Read Word	1	NO	NO	See Registers Specifications Section
39h	IOUT_CAL_OFFSET	Write Word	Read Word	2	YES	NO	See Registers Specifications Section
4Fh	OT_FAULT_LIMIT	Write Word	Read Word	2	YES	YES	See Registers Specifications Section
51h	OT_WARN_LIMIT	Write Word	Read Word	2	YES	NO	See Registers Specifications Section
55h	VIN_OV_FAULT_LIMIT	Write Word	Read Word	2	YES	NO	See Registers Specifications Section
57h	VIN_OV_WARN_LIMIT	Write Word	Read Word	2	YES	NO	See Registers Specifications Section
58h	VIN_UV_WARN_LIMIT	Write Word	Read Word	2	YES	NO	See Registers Specifications Section
78h	STATUS_BYTE	Write Byte	Read Byte	1	NO	NO	See Registers Specifications Section
79h	STATUS_WORD	Write Word	Read Word	2	NO	NO	See Registers Specifications Section
7Bh	STATUS_IOUT	Write Byte	Read Byte	1	NO	NO	See Registers Specifications Section
7Ch	STATUS_INPUT	Write Byte	Read Byte	1	NO	NO	See Registers Specifications Section
7Dh	STATUS_TEMPERATUR E	Write Byte	Read Byte	1	NO	NO	See Registers Specifications Section
7Eh	STATUS_CML	Write Byte	Read Byte	1	NO	NO	See Registers Specifications Section
88h	READ_VIN	N/A	Read Word	2	NO	NO	See Registers Specifications Section
8Bh	READ_VOUT	N/A	Read Word	2	NO	NO	See Registers Specifications Section
8Ch	READ_IOUT	N/A	Read Word	2	NO	NO	See Registers Specifications Section
8Dh	READ_TEMPERATURE	N/A	Read Word	2	NO	NO	See Registers Specifications Section
98h	PMBUS_REVISION	N/A	Read Byte	1	NO	NO	See Registers Specifications Section
ADh	IC_DEVICE_ID	N/A	Read Word	2	NO	NO	See Registers Specifications Section
AEh	IC_DEVICE_REV	N/A	Read Word	2	NO	NO	See Registers Specifications Section
C4h	PEAK_IOUT	N/A	Read Word	2	NO	NO	See Registers Specifications Section
C6h	READ_HOT_DEVICE	N/A	Read Word	2	NO	NO	See Registers Specifications Section
C7h	POWER_CYCLE	Send Byte	N/A	0	NO	NO	This command is to allow the processor to request the device to turn off and turn back on again approximately 10 seconds after shutting down. This command does not require any data. Note that once the 10 second timer elapses, the ON signal has to be high and the VIN voltage above UVLO in order for the device to restart otherwise if either condition is not met the device remains off until both signals are above their respected thresholds.
C8h	PMBUS_BASE_ADDR	Write Byte	Read Byte	1	YES	YES	See Registers Specifications Section
C9h	DEVICE_CONFIG	Write Word	Read Word	2	YES		See Registers Specifications Section

Clearing Warning or Fault Bits

Almost all of the warning or fault bits set in the status registers remain set, even if the fault or warning condition is removed or corrected, until one of the following occurs:

- The bit is individually cleared
- The device receives a CLEAR_FAULTS command
- A RESET signal (if one exists) is asserted
- The output is commanded through the ON pin, the OPERATION command, or the combined action of the ON pin and OPERATION command, to turn off and then to turn back on, or
- Bias power is removed from the PMBus device.

Removing the bias power usually means that the input power has been removed long enough that the voltage to the control circuit has decayed to zero. However, in some devices, the input power and the power to the control circuitry are separate. In this case, removing the bias power means removing the input power to the control circuitry.

The two exceptions to the rule that status bits remain set are the OFF and PG_STATUS# bits. These bits always reflect the current state of the device and the POWER_GOOD signal (if present).

Device Busy

If the NCP81428 is communicated to during power-up before reaching stand-by mode (refer to master/slave initialization) the device will set the busy bit and pull down on the ALERT#. Setting the busy will not cause a fault condition, however the device will respond as mentioned by the PMBus protocol.

If the device is too busy to accept and process a command being sent to it over the bus, it will respond as follows:

- ACK the address byte as all SMBus devices must ACK their own address
- If possible, NACK the command byte and data bytes as they are received
- If the host is attempting to read from the device, the device will send all ones (FFh) as long as the host keeps clocking and acknowledging
- Set the BUSY bit in the STATUS BYTE, and
- Notify the host by asserting the ALERT# (if not masked) As mentioned in prior sections, the user is recommended to wait 2 ms after VDD crosses the rising UVLO threshold in order to avoid setting the busy bit and asserting the ALERT#.

Response to Invalid Data or Command Faulty

If the NCP81428 receives unsupported data, the device shall:

• If possible, NACK the unsupported data bytes received before the next STOP condition,

- Flush or ignore the received command code and any received data,
- Set the CML bit in the STATUS_BYTE,
- Set the Invalid Or Unsupported Data Received bit in the STATUS CML register, and
- Notify the host by asserting ALERT# low

Unsupported Command Code

If the device receives a command that it does not support, including those command codes identified as Reserved, the device will respond as follows:

- If possible, NACK the unsupported command code and all data bytes received before the next STOP condition,
- Flush or ignore the received command code and any received data,
- Set the CML bit in the STATUS BYTE register,
- Set the Invalid Or Unsupported Command Received bit in the STATUS_CML register, and
- Notify the host by asserting ALERT# low

Alert Response Address (ARA)

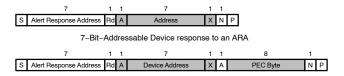
A slave-only device can signal the host through SMBALERT# that it wants to talk. The host processes the interrupt and simultaneously accesses all SMBALERT# devices through the Alert Response Address. Only the device(s) which pulled SMBALERT# low will acknowledge the Alert Response Address. The host performs a modified Receive Byte operation. The 7 bit device address provided by the slave transmit device is placed in the 7 most significant bits of the byte. The eighth bit can be a zero or one.

If more than one device pulls SMBALERT# low, the highest priority (lowest address) device will win communication rights via standard arbitration during the slave address transfer.

After receiving an acknowledge (ACK) from the master in response to its address, that device must stop pulling down on the SMBALERT# signal. If the host still sees SMBALERT# low when the message transfer is complete, it knows to read the ARA again.

A host which does not implement the SMBALERT# signal may periodically access the ARA.

The SMBus Alert Response Address is (0001 100b) and that is the one case when the R/W# bit should be set to 1.



7-Bit-Addressable Device response to an ARA with PEC

Figure 51. 7 bit-Addressable ARA Command Strings

Register Mapping

Table 11. REGISTER MAPPING

								٧	Vrite / Cle	ar R	ead / Cle	ar R	ead / Wri	te \	Write Onl	y Re	ad Only
Address	Name	B15	B14	B13	B12	B11	B10	В9	B8	В7	В6	B5	B4	В3	B2	B1	ВО
						Co	ntrol Rec	gisters									
0x01	OPERATION									op_cntl	off_beh avior				0		
0x02	ON_OFF_CONFIG												en_vcc _mode	en_op	en_cntl	en_pol	en_toff _dly
0x10	WRITE_PROTECT										write_pro				0		
0x1B	SMBALERT_MASK				mask	_byte							stati	us_x			
0x39	IOUT_CAL_OFFSET								iout_c	cal_off							
0x4F	OT_FAULT_LIMIT								ot_fl	t_lmt							
0x51	OT_WARN_LIMIT								ot_wa	ırn_lmt							
0x55	VIN_OV_FAULT_LIMIT								vin_ov	_flt_lmt							
0x57	VIN_OV_WARN_LIMIT								vin_ov_v	warn_lmt							
0x58	VIN_UV_WARN_LIMIT								vin_uv_v	warn_lmt							
0xC8	PMBUS_BASE_ADDR											m	st_addr_s	set			unused _bit
0xC9	DEVICE_CONFIG	unuse	d_bits	оср3	_level	ocp2	level	ocp1	_level	оср3	_delay	ocp2_	delay	ocp1	_delay	output_ pd	retry_ latchoff
						Sta	atus Reg	isters									
0x78	STATUS_BYTE									busy	off	vout_ov _fault	iout_oc _fault	vin_uv_ fault	temper ature	cml	none_ of_the_ above
0x79	STATUS_WORD	vout	iout_ pout	input	mfr_ specific	pg_stat us#	fans	other	unknow n	busy	off	vout_ov _fault	iout_oc _fault	vin_uv_ fault	temper ature	cml	none_ of_the_ above
0x7B	STATUS_IOUT									iout_oc _fault	iout_oc _lv_faul _t	iout_oc _warnin g	iout_uc _fault	iout_ share_ fault	iin_pwr _lmt	pout_ op_fault	pout_ warn
0x7C	STATUS_INPUT									vin_ov_ fault	vin_ov_ warn	vin_uv_ warn	vin_uv_ fault	unit_off	iin_oc_ fault	iin_oc_ warn	pin_op_ warn
0x7D	STATUS_TEMP									ot_fault	ot_warn ing	ut_warn ing	ut_fault)	
0x7E	STATUS_CML									inv_co mmand	inv_ data	packet_ error	mem_ fault	proc_ fault	0	comm_ other	Other
0x80	STATUS_MFR_SPECIFIC									gok_fau lt	scp_fau It	mst_fau lt	slv_faul t	reserve d	twi_faul t	ss_fault	dev_ temp_ warn
						R	ead Regi	sters									
0x19	CAPABILITY									pec_ cap	pmbu	s_spd	alert#_ cap	num_ format	avsbus _sup	(0
0x20	VOUT_MODE										1		vout_	mode			
0x88	READ_VIN								reac	d_vin							
0x8B	READ_VOUT								read	vout							
0x8C	READ_IOUT								read	_iout							
0x8D	READ_TEMPERATURE								read	temp							
0x98	PMBUS REVISION										rev_p	oart_I			rev_p	art_II	
0xAD	IC_DEVICE_ID								ic_de	vice_id							
0xC4	PEAK_IOUT								read_pe	eak_iout							
0xC6	READ_HOT_DEVICE								read_h	not_dev							

Register Details

Control Registers

Table 12. DETAILS FOR 0x01 - OPERATION

IUDIC	IZ. DE IAILO I	OII OXO	I OI LIIAIN	314							
0x01	OPERATIO	ON			Default = 0x00						
Bit(s)	Name	R/W	Default		Details						
7	op_cntl	R/W	0	provides another way to co	mand is used to control the pontrol the hotswap on/off functor any faults or warnings that a	tion. Upon turning on the					
				Value							
				0	Output Off						
				1	Output On						
6	off_behavior	Read	0	Bit[6] is always '0' meaning	the device will power down i	mmediately when Bit[7] = 0.					
5:0	UNUSED		0								

Table 13. DETAILS FOR 0x02 - ON_OFF_CONFIG

0x02	ON_OFF_CO	NFIG			De	efault = 0x17							
Bit(s)	Name	R/W	Default	This bit always returns a 1 meaning the unit does not power up until commanded by									
7:5	UNUSED		000										
4	en_vcc_mode	Read	1	the ON pin at NOTE: Writ Flushing or Set the CM	nd/or OPERAT ing a "0" to bit ignoring the re L bit in the ST/ alid Or Unsupp	FION command [4] the device eceived write. ATUS_BYTE,		oy:	ŕ				
3	en_op	R/W	0				e device to be of ON_OFF_CO						
				Reg 0x01h, bit[7]	Reg 0x02h, bit[4]	Reg 0x02h, bit[3]	Reg 0x02h, bit[2]	ENABLE Pin	On/Off				
				Х	1	0	1	1	On				
				1	1	1	0	Х	On				
				1	1	1	1	1	On				
				If bit [3] is cleared, and bit [2] is set, then the unit is turned on and off on ON pin. If bit [3] is set, and bit [2] is cleared, then the unit is turned on and off on commands received over the serial bus (reg1h bit 7) If bit [3] is set, and bit [2] is set, then the unit is turned on and off only who commands received over the serial bus AND the ON pin are commandity vice to be on. If either a command from the serial bus OR the ON pin country the unit to be off, the unit turns off. The en_toff_dly, bit 0 is related to the programmable turn off delay and is applicable to this device.									
2	en_cntl	R/W	1	See table bit	en_op for des	cription.							
1	en_pol	Read	1										
0	en_toff_dly	Read	1	This bit always returns a 1 meaning the unit turns off immediately when the ON pin turns off the device. NOTE: Writing a "0" to this bit the device shall respond by: • Flushing or ignoring the received write. • Set the CML bit in the STATUS_BYTE, • Set the Invalid Or Unsupported Data Received bit in the STATUS_CML register • Assert ALERT# low.									

Table 14. DETAILS FOR 0x10 - WRITE_PROTECT

0x10	WRITE_PRO	TECT			Default = 0x00							
Bit(s)	Name	R/W	Default		Details							
7:5	write_pro	R/W	000	Three bits	[7:5] are used to set the write protection level.							
				Bits [7:5]	Description							
				000	Enables writes to all commands (Default)							
				001	Disables writes to all commands except for WRITE PROTECT OPERATION and ON_OFF_CONFIG commands							
				Disables writes to all commands except for WRITE PROTECT and OPERATION commands Disables write to all commands except for WRITE PROTECT								
				The WRITE_PROTECT command is used to control writing to the PMBus device. The intent of this command is to provide protection against accidental changes. This command is not intended to provide protection against deliberate or malicious changes to a device's configuration or operation. All supported commands may have their parameters read, regardless of the WRITE_PROTECT settings.								
				If a device receives a data byte that is not listed in the table, then the device shall treat this as invalid data, declare a communications fault .If the NCP81428 receives unsupported data, the response is that the device shall:								
				Set the C Set the II	ignore the received command code and any received data, CML bit in the STATUS_BYTE, nvalid Or Unsupported Data Received bit in the STATUS_CML register RT# low to alert the host							
4:0	UNUSED		00000									

Table 15. DETAILS FOR 0x1B - SMBALERT_MASK

0x1B	SMBALERT_	MASK													
Bit(s)	Name	R/W	Default												
15:8	mask_byte	R/W	00000000	The S Byte, The I	SMBALERT provides th	_MA le Fa E, se	SK reg ult/Wa econd o	jister utilizes rning registe or highest b	s tv er a yte	wo bytes. address t is the da	STATU to be ma ata byte	S_ isk	MASK, first		
				1	7	1	1	8	1	8	3	1	8		1 1
				s	Slave Address	W	A SM MAS	IBALERT_ K Command Code	Α		us_X mand de	Α	Mask_By	te	АР
								SMBAL	LEF	RT_MASK					
					Figu	re 5	2. SM	BALERT_	M	ASK Co	mman	d S	Sequence		
					does not ma from shutting				Αl	JLT#_D p	oins, nor	do	es it preven	t the o	de-
				Bit	STATUS_ BYTE		TUS_ ORD	STATUS_ IOUT		TATUS_ INPUT	STATU TEMF		STATUS_ CML		TUS_ R_SP IFIC
				7	busy	٧	out*	iout_oc_ fault	١	/in_ov_ fault			inv_ command	gok_	fault
				6	off	iou	_pout	iout_oc_ lv_fault*	١	/in_ov_ warn	ot_ warnin	ng	inv_data	scp_	fault
				5	vout_ov_ fault*	ir	put	iout_oc_ warning*	٧	vin_uv_ warn	ut_ warnin	g*	packet_ error	mst_	fault
				4	iout_oc_ fault		nfr_ ecific	iout_uc_ fault*	٧	/in_uv_ fault	ut_fau	lt*	mem_ fault*	slv_	fault
				3	vin_uv_ fault	pg_	status #	iout_share _fault*	U	ınit_off*	unuse	d*	proc_fault	unu	sed*
					2	temperatu re	fa	ıns*	iin_pwr_ Imt*	i	in_oc_ fault*	unuse	d*	unused*	twi_
				1	cml	ot	her*	pout_op_ fault*		in_oc_ warn*	unuse	d*	comm_ other*	ss_	fault
				0	none_of_ the_above	unk	nown*	pout_ warn*		oin_op_ warn*	unuse	d*	other*	dev_ _w	temp arn
				Note that the 'off' and 'pg_status#' bits provide live status and are not maskable bits as they don't have any effect on the ALERT#. There will be no effect if they are written to. To mask the lower byte of STATUS_WORD apply SMBALERT_MASK to STATUS_BYTE. * Means a function that is not supported by the NCP81428 An attempt to write "Not supported" data given in the table above will flag an invalid data fault.											K to
				Ignores/flushes the command code and received data Sets the CML bit in STATUS_BYTE Sets the Invalid or Unsupported Data bit 6 in the STATUS_CML register Assert ALERT# to alert the host (if not masked)											

Table 15. DETAILS FOR 0x1B - SMBALERT_MASK (continued)

0x1B	SMBALERT_I	MASK	Default = 0x0000												
Bit(s)	Name	R/W	Default					D)e	tails					
7:0	status_x	R/W	00000000	Only the write function is support for this bit in the NCP81428. The SMBALERT_MASK register utilizes two bytes. STATUS_MASK, first or lowest Byte, provides the Fault/Warning register address to be masked. The MASK_BYTE, second or highest byte is the data byte bits to be masked. The SMBMALERT_MASK write protocol is shown below:											
				1	7	1 1		8	1	8	1	1 8 1 1			
				s	Slave Address	WA		BALERT_ K Command Code	А	Status_X Command Code	4	A Mask_Byte A P			
				SMBALERT_MASK											
Figure 53. S										MBALERT_MASK Command String					
				Register Name STATUS BYTE STATUS WORD STATUS_IOUT STATUS_INPUT STATUS_TEMP STATUS CML			Hex		Binary		Description				
							78		0111 1000						
							79		0111 1001						
							7B		0111 1011						
							7C		0111 1100						
							7D		0111 1101						
							7E		0111 1110						
				STATUS_MFG_SPECIAL				80		1000 0000					

Table 16. DETAILS FOR 0x39 - IOUT_CAL_OFFSET

0x39	IOUT_CAL_OI	FFSET		Default = 0xE800	
Bit(s)	Name	R/W	Default	Det	ails
15:0	iout_cal_off	R/W	1110100000000000	This command is used to null out any offsets in the current sensing circuit. The two data bytes are encoded LINEAR11 format. Exponent is in 2's compliment format and mantissa is signed binary. The default contents of the register are fuse programmable The format supported range and resolution are given in the below table. Exponent: Fixed –3 (11101b) If a device receives a data byte that is not listed in the table, then the device shall treat this as invalid data, declare a communications fault .If the NCP81428 receives unsupported data, the response is that the device shall: • Flush or ignore the received command code and any received data, • Set the CML bit in the STATUS_BYTE, • Set the Invalid Or Unsupported Data Received bit in the STATUS_CML register • Set ALERT# low to alert the host	
				Value	IOUT_CAL_OFFSET (A)
				1110 1000 0000 0000	0.000 (Default)
				1110 1000 0000 0001	0.125
				1110 1000 0000 0010	0.250
				1110 1000 0000 0011	0.375
				1110 1000 0000 0100	0.500
				1110 1000 0000 0101	0.625
				1110 1000 0000 0110	0.750
				1110 1000 0000 0111	0.875
				1110 1000 0000 1000	1.000
				1110 1000 0000 1001	1.125
				1110 1000 0000 1010	1,250
				1110 1000 0000 1011	1.375
				1110 1000 0000 1100	1.500
				1110 1000 0000 1101	1.625
				1110 1000 0000 1110	1.750
				1110 1000 0000 1111	1.875
				1110 1000 0001 0000	2.000
				1110 1111 1111 1111	-0.125
				1110 1111 1111 1110	-0.250
				1110 1111 1111 1101	-0.375
				1110 1111 1111 1100	-0.500
				1110 1111 1111 1011	-0.625
				1110 1111 1111 1010	-0.750
				1110 1111 1111 1001	-0.875
				1110 1111 1111 1000	-1.000
				1110 1111 1111 0111	-1.125 1.250
				1110 1111 1111 0110	-1.250 1.275
				1110 1111 1111 0101	-1.375 1.500
				1110 1111 1111 0100	-1.500 1.625
				1110 1111 1111 0011	-1.625 1.750
				1110 1111 1111 0010	-1.750 1.875
				1110 1111 1111 0001	-1.875 2.000
				1110 1111 1111 0000	-2.000

Table 17. DETAILS FOR 0x4F - OT_FAULT_LIMIT

0x4F	OT_FAULT_L	LIMIT		Default = 0x	kF918	
Bit(s)	Name	R/W	Default		Details	
15:0	ot_flt_lmt	R/W	1111100100011000	indicate an over temperature fault and shutdown. The OT_FAULT_LIMIT command has two data bytes encoded LIN mat with 5 bits signed exponent and 11 bits mantissa. The exponent is read only and if an exponent other –1 (11111b) is invalid data fault is flagged. The temperature can be set in 0.5C increments and the table belo examples of every two degree steps. Note that an over temperature fault limit has to be set at least 0.5° an over temperature warning limit otherwise the command will be an invalid data fault sets.		NEAR11 for- s written, an ow gives
				ot_fault_limit (Degrees °C)	Data (b)	Data (h)
				80.0	1111 1000 1010 0000	F8A0
				82.0	1111 1000 1010 0100	F8A4
				84.0	1111 1000 1010 1000	F8A8
				86.0	1111 1000 1010 1100	F8AC
				88.0	1111 1000 1011 0000	F8B0
				90.0	1111 1000 1011 0100	F8B4
				92.0	1111 1000 1011 1000	F8B8
				94.0	1111 1000 1011 1100	F8BC
				96.0	1111 1000 1100 0000	F8C0
				98.0	1111 1000 1100 0100	F8C4
				100.0	1111 1000 1100 1000	F8C8
				102.0	1111 1000 1100 1100	F8CC
				104.0	1111 1000 1101 0000	F8D0
				106.0	1111 1000 1101 0100	F8D4
				108.0	1111 1000 1101 1000	F8D8
				110.0	1111 1000 1101 1100	F8DC
				112.0	1111 1000 1110 0000	F8E0
				114.0	1111 1000 1110 0100	F8E4
				116.0	1111 1000 1110 1000	F8E8
				118.0	1111 1000 1110 1100	F8EC
				120.0	1111 1000 1111 0000	F8F0
				122.0	1111 1000 1111 0100	F8F4
				124.0	1111 1000 1111 1000	F8F8
				126.0	1111 1000 1111 1100	F8FC
				128.0	1111 1001 0000 0000	F900
				130.0	1111 1001 0000 0100	F904
				132.0	1111 1001 0000 1000	F908
				134.0	1111 1001 0000 1100	F90C
				136.0	1111 1001 0001 0000	F910
				138.0	1111 1001 0001 0100	F914
				140.0 (Default)	1111 1001 0001 1000	F918
				142.0	1111 1001 0001 1100	F91C
				144.0	1111 1001 0010 0000	F920

Table 17. DETAILS FOR 0x4F - OT_FAULT_LIMIT (continued)

0x4F	OT_FAULT_LIMIT			Default = 0xF918		
Bit(s)	Name	R/W	Default	Details		
				146.0	1111 1001 0010 0100	F924
				148.0	1111 1001 0010 1000	F928
				150.0	1111 1001 0010 1100	F92C
				Upon triggering an over-temperature fault, the following actions are taken • Set the TEMPERATURE bit in the STATUS_BYTE • Set the OT_FAULT bit in the STATUS_TEMPERATURE register, and • The device notifies the host by asserting ALERT# low if not masked)		

Table 18. DETAILS FOR 0x51 - OT_WARN_LIMIT

0x51	OT_WARN_L	IMIT		Default = 0	xF8F0	
Bit(s)	Name	R/W	Default	Details		
15:0	ot_warn_lmt	R/W	1111100011110000	This command sets the temperature in degrees Celsius at which the chip should indicate an over temperature warning. The OT_WARN_LIMIT command has two data bytes encoded LINEAR11 format with 5 bits signed exponent and 11 bits mantissa. The default contents of the register are user programmable The exponent is read only and if an exponent other –1 (11111b) is written, an invalid data fault is flagged. The mantissa range is 70°C to 150°C. Any mantissa outside this range will assert invalid data fault. Also if the ot_warn_limit is set higher or equal to ot_flt_limit then an invalid data fault is flagged. The temperature can be set in 0.5°C increments and the table below gives examples of every two degree steps. Note that an over temperature warn limit has to be set at least 0.5°C lower than an over temperature fault limit otherwise the command will be rejected and an invalid data fault sets.		
				ot_warn_limit (Degrees °C)	Data (b)	Data (h)
				70.0	1111 1000 1000 1100	F88C
				72.0	1111 1000 1001 0000	F890
				74.0	1111 1000 1001 0100	F894
				76.0	1111 1000 1001 1000	F898
				78.0	1111 1000 1001 1100	F89C
				80.0	1111 1000 1010 0000	F8A0
				82.0	1111 1000 1010 0100	F8A4
				84.0	1111 1000 1010 1000	F8A8
				86.0	1111 1000 1010 1100	F8AC
				88.0	1111 1000 1011 0000	F8B0
				90.0	1111 1000 1011 0100	F8B4
				92.0	1111 1000 1011 1000	F8B8
				94.0	1111 1000 1011 1100	F8BC
				96.0	1111 1000 1100 0000	F8C0
				98.0	1111 1000 1100 0100	F8C4
				100.0	1111 1000 1100 1000	F8C8
				102.0	1111 1000 1100 1100	F8CC
				104.0	1111 1000 1101 0000	F8D0
				106.0	1111 1000 1101 0100	F8D4
				108.0	1111 1000 1101 1000	F8D8
				110.0	1111 1000 1101 1100	F8DC

Table 18. DETAILS FOR 0x51 - OT_WARN_LIMIT (continued)

0x51	OT_WARN_	LIMIT		Default = 0	xF8F0	
Bit(s)	Name	R/W	Default		Details	
				112.0	1111 1000 1110 0000	F8E0
				114.0	1111 1000 1110 0100	F8E4
				116.0	1111 1000 1110 1000	F8E8
				118.0	1111 1000 1110 1100	F8EC
				120.0 (Default)	1111 1000 1111 0000	F8F0
				122.0	1111 1000 1111 0100	F8F4
				124.0	1111 1000 1111 1000	F8F8
				126.0	1111 1000 1111 1100	F8FC
				128.0	1111 1001 0000 0000	F900
				130.0	1111 1001 0000 0100	F904
				132.0	1111 1001 0000 1000	F908
				134.0	1111 1001 0000 1100	F90C
				136.0	1111 1001 0001 0000	F910
				138.0	1111 1001 0001 0100	F914
				140.0	1111 1001 0001 1000	F918
				142.0	1111 1001 0001 1100	F91C
				144.0	1111 1001 0010 0000	F920
				146.0	1111 1001 0010 0100	F924
				148.0	1111 1001 0010 1000	F928
				150.0	1111 1001 0010 1100	F92C
				Upon triggering an over-temperature warn, the following actions are taken: • Sets the TEMPERATURE bit in the STATUS_BYTE • Sets the OT Warning bit in the STATUS_TEMPERATURE register, and • The device notifies the host (asserts ALERT# if not masked).		

Table 19. DETAILS FOR 0x55 - VIN_OV_FAULT_LIMIT

0x55	VIN_OV_FAUL	T_LIM-		Defau	It = 0xF81C		
Bit(s)	Name	R/W	Default	Delau	Details		
15:0	vin_ov_flt_lmt	R/W	1111100000011100	This command sets the value of the input voltage VIN in volts that causes an input over voltage fault. The VIN_OV_FAULT_LIMIT command has two data bytes encoded in LINEAR11 format with 5bits signed exponent and 11 bits mantissa. The range, resolution and default are shown in the table below: Ranges Resolution Default			
				Ranges Resolution Default			
				6-8 V, 14-19 V	0.5 V	14 V	
				vin_ov_ flt_lmt	Data (B)	Data (h)	
				6.0 V	1111 1000 0000 1100	F80C	
				6.5 V	1111 1000 0000 1101	F80D	
				7.0 V	1111 1000 0000 1110	F80E	
				7.5 V	1111 1000 0000 1111	F80F	
				8.0 V	1111 1000 0001 0000	F810	
				14.0 V (Default)	1111 1000 0001 1100	F81C	
				14.5 V	1111 1000 0001 1101	F81D	
				15.0 V	1111 1000 0001 1110	F81E	
				15.5 V	1111 1000 0001 1111	F81F	
				16.0 V	1111 1000 0010 0000	F820	
				16.5 V	1111 1000 0010 0001	F821	
				17.0 V	1111 1000 0010 0010	F822	
				17.5 V	1111 1000 0010 0011	F823	
				18.0 V	1111 1000 0010 0100	F824	
				18.5 V	1111 1000 0010 0101	F825	
				19.0 V	1111 1000 0010 0110	F826	
				Upon triggering an input over-voltage fault, the following actions are taken: • Sets the NONE_OF_THE_ABOVE bit in the STATUS BYTE, • Sets the INPUT bit in the upper byte of the STATUS_WORD, • Sets the VIN_OV_FAULT bit in the STATUS_INPUT register, and • The device notifies the host (asserts PG pin low, asserts ALERT# if not masked)			

Table 20. DETAILS FOR 0x57 - VIN_OV_WARN_LIMIT

	VIN_OV_WARN	LIMIT		Default	= 0xD9A7	
Bit(s)	Name	R/W	Default		Details	
15:0	vin_ov_warn_lmt	R/W	1101100110100111	This command sets the value of the input voltage VIN in volts that causes an input over voltage warning. The VIN_OV_WARN_LIMIT command has two data bytes encoded in LINEAR11 format with 5 bits signed exponent and 11 bits mantissa. The exponent is fixed -5 (11011b). The range, resolution and default are shown in the below table. The default of this register is fuse programmable. The exponent is read only and if an exponent other than -5 (11011b) is written, an invalid data fault is flagged. An example of the supported range is given in the Table below. Any data other than given in the table below will flag an invalid data fault. NOTE: An over voltage warn limit has to be set at least 0.5 V lower than an over voltage fault limit otherwise the command will be rejected and an invalid data fault sets.		
				Range	Resolution	
				5.0 to 18.5 V	31.25 mV	
				Example VIN_OV_WARN	_LIMIT register values.	
				vin_ov_warn_lmt	Data (b)	Data (h)
				5.0 V	1101 1000 1010 0000	D8A0
				5.5 V	1101 1000 1011 0000	D8B0
				6.0 V	1101 1000 1100 0000	D8C0
				6.5 V	1101 1000 1101 0000	D8D0
				7.0 V	1101 1000 1110 0000	D8E0
				7.5 V	1101 1000 1111 0000	D8F0
				8.0 V	1101 1001 0000 0000	D900
				8.5 V	1101 1001 0001 0000	D910
				9.0 V	1101 1001 0010 0000	D920
				9.5 V	1101 1001 0011 0000	D930
				10.0 V	1101 1001 0100 0000	D940
				10.5 V	1101 1001 0101 0000	D950
				11.0 V	1101 1001 0110 0000	D960
				11.5 V	1101 1001 0111 0000	D970
				12.0 V	1101 1001 1000 0000	D980
				12.5 V	1101 1001 1001 0000	D990
				13.0 V	1101 1001 1010 0000	D9A0
				13.21875 (DEFAULT)	1101 1001 1010 0111	D9A7
				13.5 V	1101 1001 1011 0000	D9B0
				14.0 V	1101 1001 1100 0000	D9C0
				14.5 V	1101 1001 1101 0000	D9D0
				15.0 V	1101 1001 1110 0000	D9E0
				15.5 V	1101 1001 1111 0000	D9F0
				16.0 V	1101 1010 0000 0000	DA00
				16.5 V	1101 1010 0001 0000	DA10
				17.0 V	1101 1010 0010 0000	DA20
				17.5 V	1101 1010 0011 0000	DA30

Table 20. DETAILS FOR 0x57 - VIN_OV_WARN_LIMIT (continued)

	VIN_OV_WARN_LIMIT			Default = 0xD9A7				
Bit(s)	Name	R/W	Default	Details				
				18.0 V	1101 1010 0100 0000	DA40		
				18.5 V	1101 1010 0101 0000	DA50		
				Upon triggering an input over–voltage warn, the following actions are taken: • Sets the NONE_OF_THE_ABOVE bit in the STATUS_BYTE, • Sets the INPUT bit in the upper byte of the STATUS_WORD, • Sets the VIN_OV_WARN bit in the STATUS_INPUT register, and • The device notifies the host (asserts ALERT# if not masked)				

Table 21. DETAILS FOR 0x58 - VIN_UV_WARN_LIMIT

	VIN_UV_WARN_	LIMIT		Defaul	t = 0xD959	
Bit(s)	Name	R/W	Default	Details		
15:0	vin_uv_warn_lmt	R/W	1101100101011001	This command sets the varing tunder voltage warning the VIN_UV_WARN_LIM LINEAR11 format with 5 to the exponent is fixed -5. The range, resolution and the default of this registe. The exponent is read only ten, an invalid data fault is given in the Table below. It is below will flag an invalid of the voltage of the volta	bytes encoded in bits mantissa. elow table. nan -5 (11011b) is write supported range is	
				Range	Resolution	
				4.75 to 18.0 V	31.25 mV	
				Example VIN_UV_WARN		
				vin_uv_warn_lmt	Data (b)	Data (h)
				4.75 V	1101 1000 1001 1000	D898
				5.0 V	1101 1000 1010 0000	D8A0
				5.5 V	1101 1000 1011 0000	D8B0
				6.0 V	1101 1000 1100 0000	D8C0
				6.5 V	1101 1000 1101 0000	D8D0
				7.0 V	1101 1000 1110 0000	D8E0
				7.5 V	1101 1000 1111 0000	D8F0
				8.0 V	1101 1001 0000 0000	D900
				8.5 V	1101 1001 0001 0000	D910
				9.0 V	1101 1001 0010 0000	D920
				9.5 V	1101 1001 0011 0000	D930
				10.0 V	1101 1001 0100 0000	D940
				10.5 V	1101 1001 0101 0000	D950
				10.78125 (DEFAULT)	1101 1001 0101 1001	D959
				11.0 V	1101 1001 0110 0000	D960
				11.5 V	1101 1001 0111 0000	D970
				12.0 V	1101 1001 1000 0000	D980
				12.5 V	1101 1001 1001 0000	D990
				13.0 V	1101 1001 1010 0000	D9A0
				13.5 V	1101 1001 1011 0000	D9B0
				14.0 V	1101 1001 1100 0000	D9C0
				14.5 V	1101 1001 1101 0000	D9D0

Table 21. DETAILS FOR 0x58 - VIN_UV_WARN_LIMIT (continued)

	VIN_UV_WARN	_LIMIT		Default = 0xD959				
Bit(s)	Name	R/W	Default	Details				
				15.0 V	1101 1001 1110 0000	D9E0		
				15.5 V	1101 1001 1111 0000	D9F0		
				16.0 V	1101 1010 0000 0000	DA00		
				16.5 V	1101 1010 0001 0000	DA10		
				17.0 V	1101 1010 0010 0000	DA20		
				17.5 V	1101 1010 0011 0000	DA30		
				18.0 V	1101 1010 0100 0000	DA40		
				Upon triggering an input under-voltage warn, the following actions are taken: • Sets the NONE_OF_THE_ABOVE bit in the STATUS_BYTE, • Sets the INPUT bit in the upper byte of the STATUS_WORD, • Sets the VIN_UV_WARN bit in the STATUS_INPUT register, and • The device notifies the host (asserts ALERT# if not masked)				

Table 22. DETAILS FOR 0xC8 - PMBUS BASE ADDR

	PMBUS_BASE_	ADDR			Default = 0x0	C8
Bit(s)	Name	R/W	Default		С	Details
7:1	mst_addr_set	R/W	1100100		default base address	s registers should be programmed to the s is 64h, but can be programmed to other
				R _{ADDR} (kΩ)	Address	Device
				9.31	Base + 00h	Master w/ TWI Data Transfer
				14.3	Base + 01h	Master w/ TWI Data Transfer
				20.0	Base + 02h	Master w/o TWI Data Transfer
				26.7	Base + 03h	Slave 1 w/ TWI Data Transfer
				34.0	Base + 04h	Slave 2 w/ TWI Data Transfer
				42.2	Base + 05h	Slave 3 w/ TWI Data Transfer
				51.1	Base + 06h	Slave 4 w/ TWI Data Transfer
				61.9	Base + 07h	Slave 5 w/ TWI Data Transfer
				73.2	Base + 08h	Slave 6 w/ TWI Data Transfer
				86.6	Base + 09h	Slave 1 w/o TWI Data Transfer
				102.0	Base + 0Ah	Slave 2 w/o TWI Data Transfer
				118.0	Base + 0Bh	Slave 3 w/o TWI Data Transfer
				137.0	Base + 0Ch	Slave 4 w/o TWI Data Transfer
				158.0	Base + 0Dh	Slave 5 w/o TWI Data Transfer
				182.0	Base + 0Eh	Slave 6 w/o TWI Data Transfer
				Ground	Slave PMBus Disconnecte d	Slave w/ TWI Data Transfer
				VDD	Slave PMBus Disconnecte d	Slave w/o TWI Data Transfer
				Address Options	<u> </u>	
				000 0000 t	o 000 1100	Not Allowed
				000 1101 to	o 001 1000	OK

Table 22. DETAILS FOR 0xC8 - PMBUS_BASE_ADDR (continued)

	PMBUS_BASE_A	DDR		Default = 0	xC8
Bit(s)	Name	R/W	Default		Details
				010 1001 to 010 0111	Not recommended as Base Addresses
				010 1000	Not Allowed
				010 1001 to 010 1011	Not recommended as Base Addresses
				010 1100 to 010 1101	Not Allowed
				010 1110 to 011 0110	Not recommended as Base Addresses
				011 0111	Not Allowed
				011 1000 to 011 1111	Not recommended as Base Addresses
				100 0000 to 100 0100	Not Allowed
				100 0101to 100 0111	Not recommended as Base Addresses
				100 1000 to 100 1011	Not Allowed
				100 1101 to 101 0001	ок
				101 0010 to 110 0000	Not recommended as Base Addresses
				110 0001	Not Allowed
				110 0010 to 110 1000	ОК
				110 1001 to 111 0111	Not recommended as Base Addresses
				111 1000 to 111 1111	Not Allowed
				Allowed" address. Depending on the	that fall within 15 addresses under a "Not e number of Slaves, some of these address- e address of 2Eh could be used if 7 or fewer Bus.
0	unused	Read	0		

Table 23. DETAILS FOR 0xC9 - DEVICE_CONFIG

0xC9	DEVICE_CON	IFIG		Default = 0x3041							
Bit(s)	Name	R/W	Default		Details						
15:14	unused	Read	00								
13:12	ocp3_level	R/W	11	Sets the Over Current Protection level – 3.							
				Value	Description						
				00	50						
				01	60						
				10	10 70						
				11							
				Upon triggering an over-current protection fault the device shall perform the lowing actions: • Set the IOUT_OC_FAULT bit in the STATUS_BYTE • Set the IOUT bit in the STATUS_WORD • Set the IOUT_OC_FAULT bit in the STATUS_IOUT register, and • The device notifies the host (asserts PG pin low, asserts ALERT# if not materials)							
11:10	ocp2_level	R/W	00	Sets the Over Current Pro	tection level – 2.						
				Value	Description						
				00	None (Default)						
				01	25						
				10	35						
				11	45						

Table 23. DETAILS FOR 0xC9 - DEVICE_CONFIG (continued)

0xC9	DEVICE_CON	IFIG		Def	ault = 0x3041									
Bit(s)	Name	R/W	Default		Details									
				Upon triggering an over-cu lowing actions:	irrent protection fault the d	evice shall perform the fol-								
				Set the IOUT bit in the STSet the IOUT_OC_FAULT	Set the IOUT_OC_FAULT bit in the STATUS_BYTE Set the IOUT bit in the STATUS_WORD Set the IOUT_OC_FAULT bit in the STATUS_IOUT register, and The device notifies the host (asserts PG pin low, asserts ALERT# if not masked)									
9:8	ocp1_level	R/W	00	Sets the Over Current Prote	Sets the Over Current Protection level – 1.									
				Value	Description									
				00	None (Default)									
				01	10									
				10	15									
				11	20									
				Upon triggering an over-cu lowing actions: • Set the IOUT_OC_FAULT • Set the IOUT bit in the ST • Set the IOUT_OC_FAULT • The device notifies the ho	· If bit in the STATUS_BYTE IATUS_WORD If bit in the STATUS_IOUT	·								
7:6	ocp3_delay	R/W	01	O1 Sets the period of time from when the over current condition 3 is detected when the device shuts down.										
				Value	Delay (ms)									
				00	0.25									
				01	1 (Default)									
				10	10									
				11	50									
5:4	ocp2_delay	R/W	00	Sets the period of time from when the device shuts dow		ndition 2 is detected and								
				Value	Delay (ms)									
				00	0.25 (Default)									
				01	1									
				10	10									
				11	50									
3:2	ocp1_delay	R/W	00	Sets the period of time from when the device shuts dow		ndition 1 is detected and								
				Value	Delay (ms)									
				00	0.25 (Default)									
				01	1									
				10	10									
				11	50									
1	output_pd	R/W	0	To enable or Disable the int	ternal Pulldown refer to the	e settings below.								
				Value	Des	cription								
				0	0 Internal Pulldown Disabled (Defa									
				1	Internal Pul	ldown Enabled								
0	retry_latchoff	R/W	1	Value	Description									
				0	Lat	ch-Off								
				1	Auto-Re	try (Default)								
				NOTE: This bit is ignored controlled by the n	in a Slave device as the d master.	ecision to restart is								

Status Registers

Table 24. DETAILS FOR 0x78 - STATUS_BYTE

0x78	STATUS_BYT	E			Default = 0x00					
Bit(s)	Name	R/W	Default		Details					
7	busy	Read	0	This bit indi	cates if the NCP81428 is ready to communicate on the PMBus.					
				Value	Description					
				0	Device is ready to communicate. (Default)					
				1	Device is busy and unable to communicate.					
6	off	Read	0	Provides st	atus byte read if the device is not supplying power to the output.					
				Value	Description					
				0	The MOSFET is "On" (Default)					
				1	The MOSFET is "Off" This bit is asserted if the unit is not providing power to the output, regardless of the reason, including simply not being enabled.					
5	vout_ov_fault	Read	0	This feature	e is not supported. Read of this bit will always return a "0".					
4	iout_oc_fault	Read	0	Provides status byte read of the Over-Current Protections and Short Circuit faults						
				Value	Description					
				0	None of the over-current levels have been exceeded (Default)					
				1	An Over-Current limit has been exceeded					
3	vin_uv_fault	Read	0	Provides st	atus byte read of the Vin under voltage faults.					
				Value	Description					
				0	No under-voltage faults have occurred (Default)					
				1	At least one under-voltage fault has occurred.					
2	temperature	Read	0	Provides st	atus byte read of the temperature warnings and faults.					
				Value	Description					
				0	There haven't been any over-temperature warnings or over-temperature shutdowns. (Default)					
				1	At least one over-temperature warning or over temperature shutdown has occurred.					
1	cml	Read	0	Provides st	atus byte read of the communications faults.					
				Value	Description					
				0	No communication faults (Default)					
				1	Communication fault has been detected					
0	none_of_the_above	Read	0	Value	Description					
				0	No fault has occurred					
				1	A fault or warning not listed in bits [7:1] of this byte has occurred.					
				List of faults that can set this bit : VIN_OV_WARN_LIMIT VIN_UV_WARN_LIMIT						

Table 25. DETAILS FOR 0x79 - STATUS_WORD

0x79	STATUS_WO	RD			Default = 0x0800
Bit(s)	Name	R/W	Default		Details
15	vout	Read	0	This feature	is to provide information on:
				Value	Description
				0	Output Voltage fault or warning has not occurred (Default)
				1	An output voltage fault or warning has occurred
14	iout_pout	Read	0	Provides sta	atus of whether the device is.
				Value	Description
				0	Output is okay (Default)
				1	An output over–current or output power fault or warning has occurred
13	input	Read	0	Provides sta	atus of whether the input is good or not.
				Value	Description
				0	Input is good (Default)
				1	An input voltage, input current or input power fault or warning has occurred
12	mfr_specific	Read	0	This is bit is	an OR'd function of all bits in the STATUS_MFR_STATUS register.
				Value	Description
				0	No faults or warnings are reported in register 0x80, STATUS_MFR_STATUS (Default)
				1	A fault(s) or warning is shown in register 0x80, STATUS_MFR_STATUS
11	pg_status#	Read	1	This bit indiction	cates whether the voltage on the output is a valid level to operate
				Value	Description
				0	Output voltage has risen to a value close to VIN
				1	Either the output voltage has not reached a level close to VIN during soft start or the voltage has fallen to level not recommended for operation (Default)
10	fans	Read	0	This feature	is not supported. Read of this bit will always return a "0".
9	other	Read	0	This feature	is not supported. Read of this bit will always return a "0".
8	unknown	Read	0	This feature	is not supported. Read of this bit will always return a "0".
7	busy	Read	0	This bit indi	cates if the NCP81428 is ready to communicate on the PMBus.
				Value	Description
				0	Device is ready to communicate. (Default)
				1	Device is busy and unable to communicate.
6	off	Read	0	Provides sta	atus byte read if the device is not supplying power to the output.
				Value	Description
				0	The MOSFET is "On" (Default)
				1	The MOSFET is "Off"
				the reason,	sserted if the unit is not providing power to the output, regardless of including simply not being enabled. not be cleared, reflects device status.
5	vout_ov_fault	Read	0	This feature	e is not supported. Read of this bit will always return a "0".

Table 25. DETAILS FOR 0x79 - STATUS_WORD (continued)

0x79	STATUS_WOR	D			Default = 0x0800		
Bit(s)	Name	R/W	Default		Details		
4	iout_oc_fault	Read	0	Provides sta	atus byte read of the Over-Current Protections and Short Circuit faults.		
				Value	Description		
				0	None of the over-current levels have been exceeded and no short circuit fault events have occurred. (Default)		
				1	An Over-Current limit fault has been exceeded or Short Circuit event has occurred.		
3	vin_uv_fault	Read	0	Provides status byte read of the Vin under voltage faults.			
				Value	Description		
				0	No input under-voltage fault has occurred (Default)		
				1	Input under-voltage fault has occurred.		
2	temperature	Read	0	Provides status byte read of the temperature warnings and faults.			
				Value	Description		
				0	There haven't been any over-temperature warnings or over-temperature shutdowns. (Default)		
				1	At least one over-temperature warning or over temperature shutdown has occurred.		
1	cml	Read	0	Provides st	atus byte read of the communications faults.		
				Value	Description		
				0	No communication faults (Default)		
				1	Communication (memory or logic) fault has been detected		
0	none_of_the_above	Read	0	Value	Description		
				0	A fault or warning other than in bits [7:1] did not occur (Default)		
				1	A fault or warning other than in bits [7:1] has occurred (TWI data transfer fault)		

Table 26. DETAILS FOR 0x7B - STATUS_IOUT

0x7B	STATUS_IOU	Т			Default = 0x0800				
Bit(s)	Name	R/W	Default		Details				
7	iout_oc_fault	Read	0	Indicates an over current fault has occurred					
				Value Description					
				0	No over current fault has occurred. (Default)				
				1	An over current fault has occurred.				
6	iout_oc_lv_fault	Read	0	This feature is not supported. Read of this bit will always return a "0".					
5	iout_oc_warning	Read	0	This feature	is not supported. Read of this bit will always return a "0".				
4	iout_uc_fault	Read	0	This feature	is not supported. Read of this bit will always return a "0".				
3	iout_share_fault	Read	0	This feature	is not supported. Read of this bit will always return a "0".				
2	iin_pwr_lmt	Read	0	This feature	is not supported. Read of this bit will always return a "0".				
1	pout_op_fault	Read	0	This feature is not supported. Read of this bit will always return a "0".					
0	pout_warn	Read	0	This feature	is not supported. Read of this bit will always return a "0".				

Table 27. DETAILS FOR 0x7C - STATUS_INPUT

0x7C	STATUS_INPU	IT	Default = 0x00						
Bit(s)	Name	R/W	Default		Details				
7	vin_ov_fault	Read	0	Indicates an over voltage fault has occurred.					
				Value	Description				
				0	No over voltage fault on the input has occurred. (Default)				
				1	An over voltage fault on the input has occurred.				
6	vin_ov_warn	Read	0	Indicates an over voltage warning has occurred.					
				Value	Description				
				0	No over voltage warning on the input has occurred. (Default)				
				1	An over voltage warning on the input has occurred.				
5	vin_uv_warn	Read	0	Indicates an under voltage warning has occurred.					
				Value	Description				
				0	No under voltage warning on the input has occurred (Default)				
				1	An under voltage warning on the input has occurred.				
4	vin_uv_fault	Read	0	Indicates a	n under voltage fault has occurred.				
				Value	Description				
				0	No under voltage fault on the input has occurred. (Default)				
				1	An under voltage fault on the input has occurred.				
3	iout_share_fault	Read	0	This feature is not supported. Read of this bit will always return a "0".					
2	iin_pwr_lmt	Read	0	This feature is not supported. Read of this bit will always return a "0".					
1	pout_op_fault	Read	0	This feature is not supported. Read of this bit will always return a "0".					
0	pout_warn	Read	0	This feature	e is not supported. Read of this bit will always return a "0".				

Table 28. DETAILS FOR 0x7D - STATUS_TEMP

0x7D	STATUS_TEM	/IP			Default = 0x00				
Bit(s)	Name	R/W	Default		Details				
7	ot_fault	Read	0	Indicates an over temperature fault has occurred.					
				Value Description					
				0	No over temperature fault has occurred. (Default)				
				1	An over temperature fault has occurred.				
6	ot_warning	Read	0	Indicates an over temperature warning has occurred.					
				Value	Description				
				0	No over temperature warning has occurred. (Default)				
				1	An over temperature warning has occurred.				
3	ut_warning	Read	0	This feature is not supported. Read of this bit will always return a "0".					
2	ut_fault	Read	0	This feature	is not supported. Read of this bit will always return a "0".				
3:0	UNUSED		0000						

Table 29. DETAILS FOR 0x7E - STATUS_CML

0x7E	STATUS_CMI			Default = 0x00				
Bit(s)	Name	R/W	Default		Details			
7	inv_command	Read	0	Indicates an	invalid or unsupported command received.			
				Value	Description			
				0	All commands received are valid. (Default)			
				1	An invalid or unsupported command has been received.			
6	inv_data	Read	0	Indicates an invalid or unsupported data received.				
				Value	Description			
				0	All data received are valid. (Default)			
				1	An invalid or unsupported data has been received.			
5	packet_error	Read	0	Indicates a p	packet error has occurred.			
				Value	Description			
				0	No packet error communications (PEC) has occurred. (Default)			
				1	A packet error communications (PEC) has occurred.			
4	mem_fault	Read	0	This feature	is not supported. Read of this bit will always return a "0".			
3	proc_fault	Read	0	This feature is not supported. Read of this bit will always return a "0".				
2	UNUSED		0					
1	comm_other	Read	0	This feature is not supported. Read of this bit will always return a "0".				
0	Other	Read	0	This feature	is not supported. Read of this bit will always return a "0".			

Table 30. DETAILS FOR 0x80 - STATUS MFR SPECIFIC

0x80	STATUS_MFR_SP	ECIFIC			Default = 0x00
Bit(s)	Name	R/W	Default		Details
7	gok_fault	Read	0	Value	Description
				0	No GOK fault has occurred. (Default)
				1	A GOK fault has occurred.
6	scp_fault	Read	0	Value	Description
				0	No SCP fault has occurred. (Default)
				1	An SCP fault has occurred.
5	mst_fault	Read	0	Value	Description
				0	No Master fault has occurred. (Default)
				1	A Master fault has occurred.
4	slv_fault	Read	0	Value	Description
				0	No Slave fault has occurred. (Default)
				1	A Slave fault has occurred.
3	reserved	Read	0	This feature	is not supported. Read of this bit will always return a "0".
2	twi_fault	Read	0	Value	Description
				0	No failure to transmit Master data to Slave has occurred. (Default)
				1	A failure to transmit Master data to Slave has occurred.
1	ss_fault	Read	0	Value	Description
				0	No soft-start current limiting fault (250us qualified) has occurred. (Default)
				1	A soft-start current limiting fault (250us qualified) has occurred.
0	dev_temp_warn	Read	0	Value	Description
				0	Die temperatures evened out across devices on the board (Default)
				1	Die temperatures are uneven, requires attention.

Read Registers

Table 31. DETAILS FOR 0x19 - CAPABILITY

0x19	CAPABILIT	Υ			Default = 0xB0
Bit(s)	Name	R/W	Default		Details
7	pec_cap	Read	1	Value	Description
				0	Packet Error Checking (PEC) is not supported
				1	Packet Error Checking (PEC) enabled (Default)
6:5	pmbus_spd	Read	01	Value	Description
				00	Maximum communication speed is 100 kHz
				01	Maximum communication speed is 400 kHz (Default)
				10	Maximum communication speed is 1 MHz (Not Supported)
				11	Reserved
4	alert#_cap	Read	1	Value	Description
				0	Device does not have Alert# pin and does not support PMBus Alert Response Protocol.
				1	Device provides an Alert# pin and supports PMBus Alert Response protocol (Default)
3	num_format	Read	0	Numeric Fo	ormat support
				Value	Description
				0	Numeric data is LINEAR11, ULINEAR 16, SLINEAR 16 or DIRECT FORMAT (Default)
				1	Numeric data is IEEE Half Precision Floating Point.
2	avsbus_sup	Read	0	AVSBus su	pport
				Value	Description
				0	AVSBus is not supported (Default)
				1	AVSBus is supported
1:0	UNUSED		00		

Table 32. DETAILS FOR 0x20 - VOUT_MODE

0x20	VOUT_MODI	Ξ			Default = 0xB0							
Bit(s)	Name	R/W	Default		Details							
7:0	vout_mode	Read	00011011	This establishes the 5 bit 2's complement exponent for the 16 bit mantissa delivered as data bytes for the READ Vout command (8Bh).								
				VOUT MODE DATA BYTE:								
				7 6 5 4 3 2 1				0				
				Mode				Exponent (N)				

Table 33. DETAILS FOR 0x88 - READ_VIN

0x88	READ_V	'IN		Default = 0xD800		
Bit(s)	Name	R/W	Default	Details		
15:0	read_vin	Read	1101100000000000	Range	Range Resolution	
				0 to 31.96875 V	31.25 mV	
				Two data bytes are encode	returns the measured inputed in LINEAR11 format with exponent is fixed –5 (11011 ter values.	5 bits signed exponent
				Data (h)	Data (b)	VIN
				D800	1101 1000 0000 0000	0.00
				D8C0	1101 1000 1100 0000	6.00
				D900	1101 1001 0000 0000	8.00
				D940	1101 1001 0100 0000	10.00
				D980	1101 1001 1000 0000	12.00
				D9C0	1101 1001 1100 0000	14.00
				DA00	1101 1010 0000 0000	16.00
				DA40	1101 1010 0100 0000	18.00
				DA80	1101 1010 1000 0000	20.00
				DAC0	1101 1010 1100 0000	22.00
				DB00	1101 1011 0000 0000	24.00
				DBFF	1101 1011 1111 1111	31.96875

Table 34. DETAILS FOR 0x8B - READ_VOUT

0x8B	READ_VO	UT		Defau	ult = 0x0000	
Bit(s)	Name	R/W	Default	Details		
15:0	read_vout	Read	0000000000000000	Range	Resolution	
				0 to 31.96875 V	31.25 mV	
				The READ_VOUT comma Two data bytes are encod Example READ_VOUT re	and returns the measured out led in ULINEAR16 format as gister values.	put voltage (VOUT), Volts. shown below:
				Data (h) Data (b) VOUT		
				0000	0000 0000 0000 0000	0.00
				00C0	0000 0000 1100 0000	6.00
				0100	0000 0001 0000 0000	8.00
				0140	0000 0001 0100 0000	10.00
				0180	0000 0001 1000 0000	12.00
				01C0	0000 0001 1100 0000	14.00
				0200	0000 0010 0000 0000	16.00
				0240	0000 0010 0100 0000	18.00
				0280	0000 0010 1000 0000	20.00
				03FF	0000 0011 1111 1111	31.96825

Table 35. DETAILS FOR 0x8C - READ_IOUT

0x8C	READ_IO	UT		Default = 0xE800			
Bit(s)	Name	R/W	Default	Details			
15:0	read_iout	Read	1110100000000000	Range	Resolution		
				0 to +127.875 A	125 mA		
				The IOUT register provides a digitized value of the voltage developed across the equivalent resistance on the IMON pins. In an application where there is a single eFuse, this voltage is representative of the current the device is delivering to the load. In an application where multiple eFuses are in parallel, the digitized voltage value represents the total load current delivered by the eFuse devices, divided by the number of eFuses in parallel. This is based on the equivalent resistance of all R _{IMON} resistors of each eFuse being in parallel. For instance: If 5 eFuses are in parallel, the Req = 2 k Ω /5 = 400 Ω . The READ_IOUT command returns the measured output current IOUT, Amps. Two data bytes are encoded in LINEAR11 format with 5 bits signed exponent and 11 bits mantissa. The exponent is fixed –3(11101b). In this application, the current should never be negative and thus bit [10] should always be 0.		there is a is delivering he digitized se devices, uivalent r instance: If IT, Amps. xponent and	
				always be 0. Example READ_IOUT register values.			
				Data (h)	Data (b)	IOUT (A)	Vimon (V)
				E800	1110 1000 0000 0000	0.00	0.00
				E850	1110 1000 0101 0000	10.00	0.20
				E8A0	1110 1000 1010 0000	20.00	0.40
				E8F0	1110 1000 1111 0000	30.00	0.60
				E940	1110 1001 0100 0000	40.00	0.80
				E990	1110 1001 1001 0000	50.00	1.00
				E9E0	1110 1001 1110 0000	60.00	1.20
				EA30	1110 1010 0011 0000	70.00	1.40
				EA80	1110 1010 1000 0000	80.00	1.60
				EAD0	1110 1010 1101 0000	90.00	1.80
				EB20	1110 1011 0010 0000	100	2.0
				EBFF	1110 1011 1111 1111	127.875	2.575
				equivalent resista	r eFuse. In parallel configur unce will be 2 k Ω /#D, where s connected in parallel.		

Table 36. DETAILS FOR 0x8D - READ_TEMPERATURE

0x8D	READ_TEMPERATURE			Default = 0xF828		
Bit(s)	Name	R/W	Default	Details		
15:0	read_temp	Read	1111100000101000	Range	Resolution	
				-20.00°C to +256.00°C	0.5°C	
				The READ_TEMPERATURE command returns the internal device temperature. Two data bytes are encoded in LINEAR11 format with 5 bits signed exponent an 11 bits mantissa. The exponent is fixed –1 (11111b). Example READ_TEMP register values.		
				Data (h) Data (b) IC Temp		IC Temp
				FFD8	1111 1111 1101 1000	-20.0
				F800	1111 1000 0000 0000	0.00
				F828	1111 1000 0010 1000	20.0
				F850	1111 1000 0101 0000	40.0
				F878	1111 1000 0111 1000	60.0
				F8A0	1111 1000 1010 0000	80.0
				F8C8	1111 1000 1100 1000	100.0
				F8F0	1111 1000 1111 0000	120.0
				F918	1111 1001 0001 1000	140.0
				F92C	1111 1001 0010 1100	150.0

Table 37. DETAILS FOR 0x98 - PMBUS REVISION

0x98	PMBUS REV	ISION		Defa	ult = 0x33	
Bit(s)	Name	R/W	Default	Details		
7:4	rev_part_I	Read	0101	PMBUS_REVISION command Stores or reads the revision of the PMBus to which the device is compliant. The command has one data byte. Bits [7:4] indicate the revision of the PMBu specification Part I to which the device is compliant. Devices may support this as a read only command.		
				Bits [7:4]	Part I Revision	
				0000b	1.0	
				0001b	1.1	
				0010b	1.2	
				0011b	1.3	
				0100b	1.3.1	
				0101b	1.4 (Default)	
3:0	rev_part_II	Read	0101	which the device is complia	ta byte. Bits [3:0] indicate the h the devices compliant.	
				Bits [3:0]	Part II Revision	
				0000b	1.0	
				0001b	1.1	
				0010b	1.2	
				0011b	1.3	
				0100b	1.3.1	
				0101b	1.4 (Default)	

Table 38. DETAILS FOR 0xAD - IC_DEVICE_ID

0xAD	IC_DEVICE	_ID	Default = 0x2800				
Bit(s)	Name	R/W	Default	Details			
15:0	ic_device_id	Read	00101000000000000	number information. The Block Read format must be used to access this 2 byte read.		yte read.	
				UPDATE	Device ID (b)	Device ID (h)	Device P/N
				[15:0]	0010, 1000, 0000 00XX	2800 2801 2802 2803	NCP81428 – 64h NCP81428A – 4Ch NCP81428B – 38h NCP81428C – 0Dh

Table 39. DETAILS FOR 0xC4 - PEAK_IOUT

0xC4	PEAK_IOU	JT		Defau	Default = 0xE800		
Bit(s)	Name	R/W	Default	Details			
15:0	read_peak_iout	R/CLR	1110100000000000	Range Resolution			
				0 to +127.875 A 125 mA			
				The PEAK_IOUT command returns the measured peak output current at an OC event, Amps. Two data bytes are encoded in LINEAR11 format with 5 bits signed exponent at 11 bits mantissa. The exponent is fixed –3 (11101b). In this application, the current should never be negative and thus bit [10] should always be 0. Note that PEAK_IOUT reporting shares the same accuracy and resolution as IOUT reporting. Example PEAK_IOUT register values.		xponent and	
				Data (h) Data (b) IOUT (A) Vimon		Vimon (V)	
ļ				E800	1110 1000 0000 0000	0.00	0.00
ļ				E850	1110 1000 0101 0000	10.00	0.20
				E8A0	1110 1000 1010 0000	20.00	0.40
				E8F0	1110 1000 1111 0000	30.00	0.60
				E940	1110 1001 0100 0000	40.00	0.80
				E990	1110 1001 1001 0000	50.00	1.00
				E9E0	1110 1001 1110 0000	60.00	1.20
				EA30	1110 1010 0011 0000	70.00	1.40
				EA80	1110 1010 1000 0000	80.00	1.60
				EAD0	1110 1010 1101 0000	90.00	1.80
				EB20 1110 1011 0010 0000 100		2.0	
				EBFF	1110 1011 1111 1111	127.875	2.575
				equivalent resista	or eFuse. In parallel configurance will be 2 k Ω /#D, where s connected in parallel.		

Table 40. DETAILS FOR 0xC6 - READ_HOT_DEVICE

0xC6	READ_HOT_DEVICE			Default = 0xF828		
Bit(s)	Name	R/W	Default	Details		
15:0	read_hot_dev	Read	1111100000101000	Range	Resolution	
				-256.00°C to +256.00°C	0.5°C	
				The READ_HOT_DEVICE command returns the hottest measured die in the application. The VTEMP output can source much more current than it can sink that if multiple VTEMP outputs are connected together, the voltage of all VTEM outputs will be driven to the voltage produced by the hottest NCP81428. Two data bytes are encoded in LINEAR11 format with 5 bits signed exponent a 11 bits mantissa. The exponent is fixed –1 (11111b). Example READ_HOT_DEVICE register values.		current than it can sink, so the voltage of all VTEMP ttest NCP81428.
			•	Data (h)	Data (b)	IC Temp
			•	F800	1111 1000 0000 0000	0.00
				F828	1111 1000 0010 1000	20.0
				F850	1111 1000 0101 0000	40.0
				F878	1111 1000 0111 1000	60.0
				F8A0	1111 1000 1010 0000	80.0
				F8C8	1111 1000 1100 1000	100.0
				F8F0 1111 1000 1111 0000 120.0		120.0
				F918	1111 1001 0001 1000	140.0
				F92C	1111 1001 0010 1100	150.0

Application Circuit

Application Circuit Diagram

Single eFuse Application Circuit System VIN Application Processor NCP81428 VDD Fuse Protected **ENABLE OUT** System VIN SDA SDA SCL SCL FAULT#_C ALERT# ALERT# FAULT#_D PG ADDR VTEMP

Figure 54. Application Circuit

Application Circuit Components

Table 41. PRIMARY COMPONENTS

Component	Manufacturer	Part Number	Value	Case Size	Voltage Rating
R _{VINF}	Vishay	CRCW06031R00FKEA	1 Ω	0603	75 V
C _{VINF}	Murata	0603YC104KAT2A	0.1 μF	0603	16 V
C _{VDD}	Murata	GRM188C81E475KE11D	4.7 μF	0603	25 V
R _{Imon}	KOA Speer	RK73H1JTTD2001F	2 kΩ	0603	75 V
C _{SS}	Murata	0603YC104KAT2A	0.1 μF	0603	16 V
D _{IN}	LittleFuse	SMBJ13A	Clamping Voltage = 21.5 V, Peak Current = 28 A	DO- 214AA, 3.30 mm x 4.06 mm	Vr = 13 V
D _{OUT}	onsemi	MBR2045EMFST3G	20 A	8-SOFL, 5 mm x 6 mm	45 V

Application Component Guidelines

Transient Voltage Suppression

Hotswap eFuses are prone to sudden interruption in current flow, input cable inductance creates a positive voltage transient spike on the input of the device. These type of events if not suppressed by an external TVS diode they could easily exceed the AMR of the NCP81428. Similarly,

output inductance creates a negative voltage spike on the output of the device that needs to be clamped by a diode with the cathode connected to ground and the anode to Vout.

Users can roughly estimate the magnitudes of these spike by referring to the Formula below:

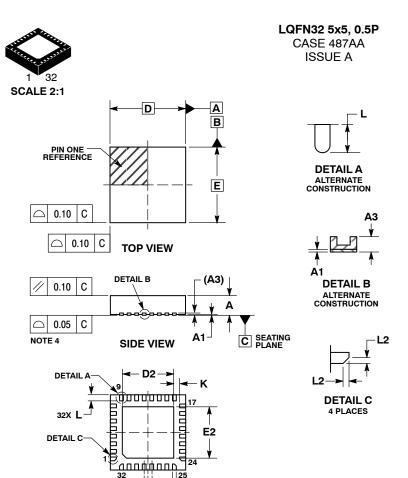
$$V_{Spike} = V_{DC} + I_{OUT} \times \sqrt{(L/C)}$$
 (eq. 3)

ORDERING INFORMATION

Device Order Number	Specific Device Marking	Package Type	Shipping [†]
NCP81428MNTXG	NCP81428	LQFN32 5x5, 0.5P	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PMBus is a registered trademark of SMIF, Inc. $\textbf{onsemi} \text{ is licensed by the Philips Corporation to carry the } 1^2\text{C bus protocol}.$



DATE 03 OCT 2017

NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS.
- CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION & APPLIES TO PLATED
 TERMINAL AND IS MEASURED BETWEEN
 O 15 AND 0 30 MM EPOM THE TERMINAL TIE
- 0.15 AND 0.30 MM FROM THE TERMINAL TIP.
 4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS			
DIM	MIN	MAX		
Α	1.20	1.40		
A1	-	0.05		
А3	0.20	REF		
b	0.18	0.30		
D	5.00	BSC		
D2	3.30	3.50		
E	5.00	BSC		
E2	3.30	3.50		
е	0.50	BSC		
L	0.30	0.50		
L2	0.13	REF		

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

A = Assembly Location WL = Wafer Lot

YY = Year WW = Work Week ■ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

RECOMMENDED SOLDERING FOOTPRINT*

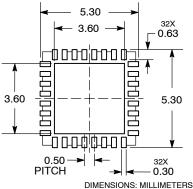
BOTTOM VIEW

0.10 M C A B

0.05 M C NOTE 3

е

e/2



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION: LQFN32, 5x5, 0.5P PAGE 1 OF 1

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